SONY

Diagonal 6.46 mm (Type 1/2.8) CMOS Solid-state Image Sensor with Square Pixel for Color Cameras

Tentative

IMX307LQR-C

STARVIS

Description

The IMX307LQR-C is a diagonal 6.46 mm (Type 1/2.8) CMOS active pixel type solid-state image sensor with a square pixel array and 2.13 M effective pixels. This chip operates with analog 2.9 V, digital 1.2 V, and interface 1.8 V triple power supply, and has low power consumption. High sensitivity, low dark current and no smear are achieved through the adoption of R, G and B primary color mosaic filters. This chip features an electronic shutter with variable charge-integration time.

(Applications: Surveillance cameras, FA cameras, Industrial cameras)

Features

- ◆ CMOS active pixel type dots
- ◆ Built-in timing adjustment circuit, H/V driver and serial communication circuit
- ◆ Input frequency: 74.25 MHz / 37.125 MHz
- ♦ Number of recommended recording pixels: 1920 (H) x 1080 (V) approx. 2.07M pixel
- ◆ Readout mode

All-pixel scan mode

720p-HD readout mode

Window cropping mode

Vertical / Horizontal direction-normal / inverted readout mode

◆ Readout rate

Maximum frame rate in Full HD 1080p mode: 60 frame / s

◆ Wide dynamic range (WDR) function

Multiple exposure WDR

Digital overlap WDR

- ◆ Variable-speed shutter function (resolution 1H units)
- ◆ 10-bit / 12-bit A/D converter
- ◆ Conversion gain switching (HCG Mode / LCG Mode)
- ◆ CDS / PGA function

0 dB to 27 dB: Analog Gain 27 dB (step pitch 0.3 dB)

27.3 dB to 69 dB: Analog Gain 27 dB + Digital Gain 0.3 to 42 dB (step pitch 0.3 dB)

◆ Supports I/O switching

Low voltage LVDS (150 m Vp-p) serial (2 ch / 4 ch switching) DDR output CSI-2 serial data output (2 Lane / 4 Lane, RAW10 / RAW12 output)

◆ Recommended exit pupil distance: -30 mm to -∞



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Application circuits shown, if any, are typical examples illustrating the operation of the devices. Sony Semiconductor Solutions Corporation cannot assume responsibility for any problems arising out of the use of these circuits.

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Device Structure

- ◆ CMOS image sensor
- ◆ Image size Type 1/2.8
- ◆ Total number of pixels 1945 (H) x 1109 (V) approx. 2.16 M pixels
- ◆ Number of effective pixels 1945 (H) × 1097 (V) approx. 2.13 M pixels
- ♦ Number of active pixels 1937 (H) x 1097 (V) approx. 2.12 M pixels
- ◆ Number of recommended recording pixels 1920 (H) x 1080 (V) approx. 2.07 M pixels
- ◆ Unit cell size 2.9 µm (H) x 2.9 µm (V)
- ◆ Optical black Horizontal (H) direction: Front 0 pixels, rear 0 pixels Vertical (V) direction: Front 10 pixels, rear 0 pixels
- ◆ Dummy
 Horizontal (H) direction: Front 0 pixels, rear 3 pixels
 Vertical (V) direction: Front 0 pixels, rear 0 pixels
- Substrate material Silicon

Absolute Maximum Ratings

Item	Symbol	Min.	Max.	Unit	Remarks
Supply voltage (analog 2.9 V)	AV_{DD}	-0.3	3.3	V	
Supply voltage (interface 1.8 V)	OV_{DD}	-0.3	3.3	V	
Supply voltage (digital 1.2 V)	DV_DD	-0.3	2.0	V	
Input voltage	VI	-0.3	OV _{DD} + 0.3	V	Not exceed 3.3 V
Output voltage	VO	-0.3	OV _{DD} + 0.3	V	Not exceed 3.3 V

Application Conditions

Item	Symbol	Min.	Тур.	Max.	Unit
Supply voltage (analog 2.9 V)	AV _{DD}	2.80	2.90	3.00	V
Supply voltage (Interface 1.8 V)	OV_{DD}	1.70	1.80	1.90	V
Supply voltage (digital 1.2 V)	DV_{DD}	1.10	1.20	1.30	V
Performance guarantee temperature	Tspec	-10	_	60	°C
Operating guarantee temperature	Topr	-30	_	85	°C
Storage guarantee temperature	Tstg	-40	_	85	°C

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General-0.0.9

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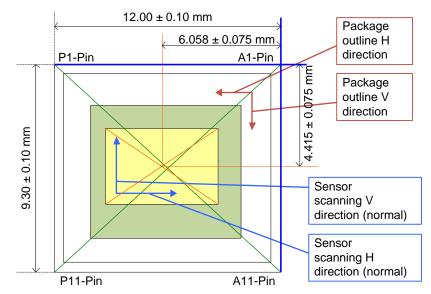
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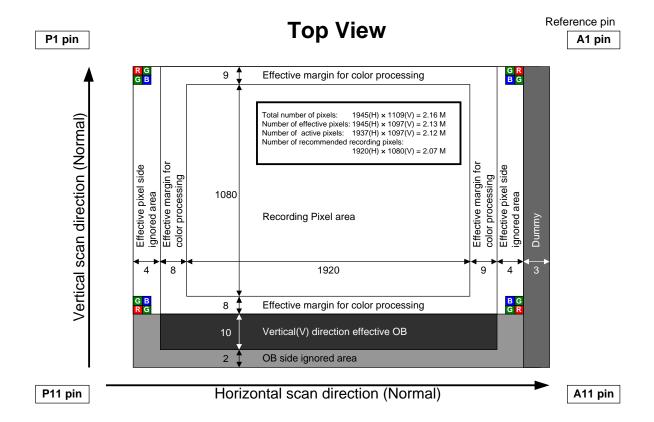
Optical Center

Top View Package center Optical center Package reference (H, V)



Optical Center

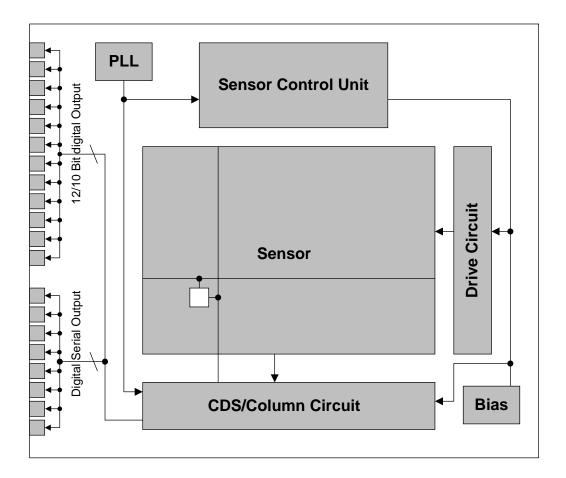
Pixel Arrangement



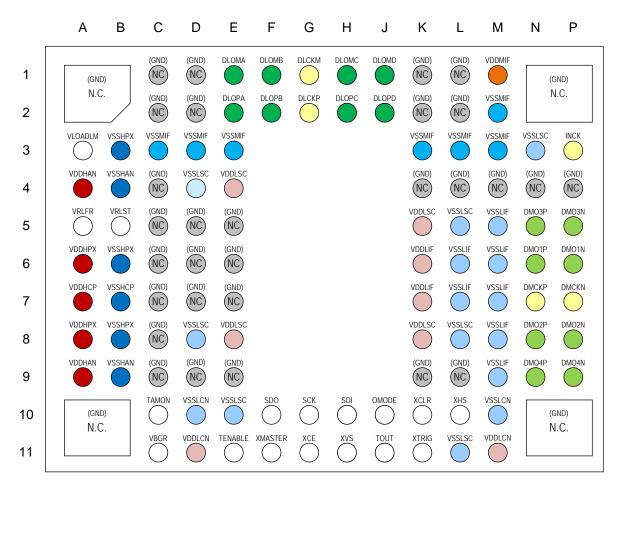
^{*} Reference pin number is consecutive numbering of package pin array. See the Pin Configuration for the number of each pin.

Pixel Arrangement (Top View)

Block Diagram and Pin Configuration



Block Diagram



Analog Power Supply (2.9V)

Analog GND

Digital Power Supply (1.8V)

Digital GND

Digital GND

Clock

Data output (LVDS)

Data output (CSI-2)

Pin Configuration (Bottom View)

^{*}The N.C. pin can be connected to GND.

Pin Description

No.	Pin No	I/O	Analog /Digital	Symbol	Description	Remarks
1	A1	_	_	N.C.	_	GND connectable
2	А3	0	А	VLOADLM	Reference pin	
3	A4	Power	А	VDDHAN	2.9 V power supply	
4	A5	0	А	VRLFR	Reference pin	
5	A6	Power	А	VDDHPX	2.9 V power supply	
6	A7	Power	А	VDDHCP	2.9 V power supply	
7	A8	Power	Α	VDDHPX	2.9 V power supply	
8	A9	Power	Α	VDDHAN	2.9 V power supply	
9	A11	_	_	N.C.	_	GND connectable
10	В3	GND	Α	VSSHPX	2.9 V GND	
11	В4	GND	Α	VSSHAN	2.9 V GND	
12	B5	0	Α	VRLST	Reference pin	
13	В6	GND	Α	VSSHPX	2.9 V GND	
14	В7	GND	Α	VSSHCP	2.9 V GND	
15	В8	GND	Α	VSSHPX	2.9 V GND	
16	В9	GND	Α	VSSHAN	2.9 V GND	
17	C1	_	_	N.C.	_	GND connectable
18	C2	_	_	N.C.	_	GND connectable
19	C3	GND	D	VSSMIF	1.8 V GND	
20	C4	_	_	N.C.	_	GND connectable
21	C5	_	_	N.C.	_	GND connectable
22	C6	_	_	N.C.	_	GND connectable
23	C7	_	_	N.C.	_	GND connectable
24	C8	_	_	N.C.	_	GND connectable
25	C9	_	ı	N.C.	_	GND connectable
26	C10	0	Α	TAMON	TEST output pin	OPEN
27	C11	0	А	VBGR	Reference pin	
28	D1	_	ı	N.C.	_	GND connectable
29	D2	_	I	N.C.	_	GND connectable
30	D3	GND	D	VSSMIF	1.8 V GND	
31	D4	GND	D	VSSLSC	1.2 V GND	
32	D5	_	_	N.C.	_	GND connectable
33	D6	_		N.C.	_	GND connectable
34	D7	_		N.C.	_	GND connectable
35	D8	GND	D	VSSLSC	1.2 V GND	
36	D9	_	_	N.C.	_	GND connectable
37	D10	GND	D	VSSLCN	1.2 V GND	
38	D11	Power	D	VDDLCN	1.2 V power supply	

No.	Pin No	I/O	Analog /Digital	Symbol	Description	Remarks
39	E1	0	D	DLOMA	LVDS output	data
40	E2	0	D	DLOPA	LVDS output	data
41	E3	GND	D	VSSMIF	1.8 V GND	
42	E4	Power	D	VDDLSC	1.2 V power supply	
43	E5	_	_	N.C.		GND connectable
44	E6	_	_	N.C.	_	GND connectable
45	E7	_	_	N.C.	_	GND connectable
46	E8	Power	D	VDDLSC	1.2 V power supply	
47	E9	_	_	N.C.	_	GND connectable
48	E10	GND	D	VSSLSC	1.2 V GND	
49	E11	I	D	TENABLE	TEST Enable	OPEN
50	F1	0	D	DLOMB	LVDS output	data
51	F2	0	D	DLOPB	LVDS output	data
52	F10	0	D	SDO	Communication output	4-wire: SDO pin I ² C: Open
53	F11	I	D	XMASTER	Master / Slave selection	High: Slave mode / Low: Master mode
54	G1	0	D	DLCKM	LVDS output	clock
55	G2	0	D	DLCKP	LVDS output	clock
56	G10	ı	D	SCK	Communication clock	4-wire: SCK pin I ² C: SCL pin
57	G11	I	D	XCE	Communication enable	4-wire: XCE pin I ² C: Fixed to High
58	H1	0	D	DLOMC	LVDS output	data
59	H2	0	D	DLOPC	LVDS output	data
60	H10	I/O	D	SDI	Communication input	4-wire: SDI pin I ² C: SDA pin
61	H11	I/O	D	XVS	Vertical sync signal	
62	J1	0	D	DLOMD	LVDS output	data
63	J2	0	D	DLOPD	LVDS output	data
64	J10	I	D	OMODE	Serial output interface selection	High: LVDS / Low: CSI-2
65	J11	0	D	TOUT	TEST output pin	OPEN
66	K1	_	_	N.C.	_	GND connectable
67	K2	_	_	N.C.	_	GND connectable
68	K3	GND	D	VSSMIF	1.8 V GND	
69	K4	_	_	N.C.	_	GND connectable
70	K5	Power	D	VDDLSC	1.2 V power supply	
71	K6	Power	D	VDDLIF	1.2 V power supply	
72	K7	Power	D	VDDLIF	1.2 V power supply	
73	K8	Power	D	VDDLSC	1.2 V power supply	
74	K9	_	_	N.C.	_	GND connectable
75	K10	I	D	XCLR	System clear	High: Normal / Low: Clear
76	K11	I	D	XTRIG	Trigger mode input	OPEN
77	L1	_	_	N.C.	_	GND connectable
78	L2	_	_	N.C.	_	GND connectable



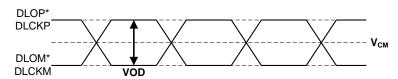
No.	Pin No	I/O	Analog /Digital	Symbol	Description	Remarks
79	L3	GND	D	VSSMIF	1.8 V GND	
80	L4	_	_	N.C.	_	GND connectable
81	L5	GND	D	VSSLSC	1.2 V GND	
82	L6	GND	D	VSSLIF	1.2 V GND	
83	L7	GND	D	VSSLIF	1.2 V GND	
84	L8	GND	D	VSSLSC	1.2 V GND	
85	L9	_	_	N.C.	_	GND connectable
86	L10	I/O	D	XHS	Horizontal sync signal	
87	L11	GND	D	VSSLSC	1.2 V GND	
88	M1	Power	D	VDDMIF	1.8 V power supply	
89	M2	GND	D	VSSMIF	1.8 V GND	
90	МЗ	GND	D	VSSMIF	1.8 V GND	
91	M4	_	_	N.C.	_	GND connectable
92	M5	GND	D	VSSLIF	1.2 V GND	
93	M6	GND	D	VSSLIF	1.2 V GND	
94	M7	GND	D	VSSLIF	1.2 V GND	
95	M8	GND	D	VSSLIF	1.2 V GND	
96	M9	GND	D	VSSLIF	1.2 V GND	
97	M10	GND	D	VSSLCN	1.2 V GND	
98	M11	Power	D	VDDLCN	1.2 V power supply	
99	N3	GND	D	VSSLSC	1.2 V GND	
100	N4		_	N.C.	_	GND connectable
101	N5	0	D	DMO3P	CSI-2 output	data
102	N6	0	D	DMO1P	CSI-2 output	data
103	N7	0	D	DMCKP	CSI-2 output	clock
104	N8	0	D	DMO2P	CSI-2 output	data
105	N9	0	D	DMO4P	CSI-2 output	data
106	P1		_	N.C.	_	GND connectable
107	P3	I	D	INCK	Master clock input	
108	P4		_	N.C.	_	GND connectable
109	P5	0	D	DMO3N	CSI-2 output	data
110	P6	0	D	DMO1N	CSI-2 output	data
111	P7	0	D	DMCKN	CSI-2 output	clock
112	P8	0	D	DMO2N	CSI-2 output	data
113	P9	0	D	DMO4N	CSI-2 output	data
114	P11	_	_	N.C.	_	GND connectable

Electrical Characteristics

DC Characteristics

Item	Item		Symbol	Condition	Min.	Тур.	Max.	Unit
	analog	VDDHx	AV_{DD}		2.80	2.90	3.00	V
Supply voltage	Interface	VDDMx	OV_{DD}		1.70	1.80	1.90	V
	digital	VDDLx	DV_DD		1.10	1.20	1.30	V
		XHS XVS XCLR INCK XMASTER	VIH	XVS / XHS	0.8OV _{DD}	ı	_	>
Digital input vol	ilage	OMODE SCK SDI XCE XTRIG	VIL	Slave Mode	_	ı	0.20V _{DD}	V
		DLOP [A:D] DLOM		Low voltage LVDS	_	OV _{DD} /2	_	V
Digital output voltage		[A:D] DLCKP DLCKM		Low voltage LVDS (Termination resistance: 100 Ω)	100	150	220	mV
			VOH	XVS / XHS	OV _{DD} -0.4	_	_	V
		XVS SDO TOUT VOL		Master Mode	_		0.4	V





Current Consumption

			Ту	/p.	Ma		
Item	pin	Symbol	Standard luminous intensity	Saturated luminous intensity	Standard luminous intensity	Saturated luminous intensity	Unit
Operating current	VDDHx	IAV_{DD}	54	53	99	97	mA
Low voltage LVDS serial 4ch 12 bit, 60 frame/s	VDDMx	IOV _{DD}	16	15	25	24	mA
Full HD 1080p mode	VDDLx IDV _{DD}		77	95	110	142	mA
Operating current	VDDHx	IAV _{DD}	55	54	99	97	mA
MIPI CSI-2 / 4 Lane 12 bit, 60 frame/s	VDDMx	IOV _{DD}	1	1	1	1	mA
Full HD 1080p mode	VDDLx	IDV _{DD}	94	111	130	164	mA
	VDDHx	VDDHx IAV _{DD} _STB		_		.1	mA
Standby current	VDDMx	IOV _{DD} _STB	-	_	0	.1	mA
	VDDLx	IDV _{DD} _STB	_		14	4.9	mA

Operating current: (Typ.) Supply voltage 2.90 V / 1.8 V / 1.2 V, Tj = 25 $^{\circ}$ C

(Max.) Supply voltage 3.00 V / 1.9 V / 1.3 V, Tj = 60 $^{\circ}$ C, worst state of internal circuit

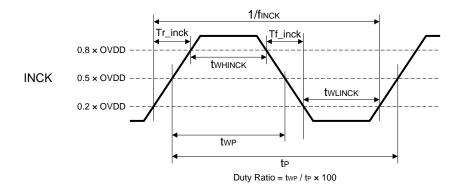
operating current consumption,

Standby: (Max.) Supply voltage 3.00 V / 1.9 V / 1.3 V, Tj = $60 ^{\circ}$ C, INCK: 0 V, light-obstructed state.

Standard luminous intensity: luminous intensity at 1/3 of the sensor saturated Saturated luminous intensity: luminous intensity when the sensor is saturated.

AC Characteristics

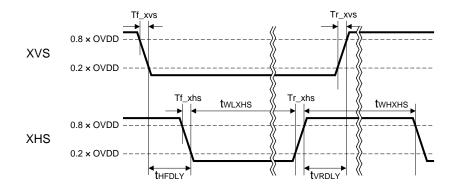
Master Clock Waveform (INCK)



Item	Symbol	Min.	Тур.	Max.	Unit	Remarks
INCK clock frequency	f _{INCK}	f _{INCK} × 0.96	f _{INCK}	f _{INCK} × 1.02	MHz	f _{INCK} = 37.125 MHz, 74.25 MHz
INCK Low level pulse width	t _{WLINCK}	4	_	_	ns	f _{INCK} = 37.125 MHz, 74.25 MHz
INCK High level pulse width	twHINCK	4	_	_	ns	f _{INCK} = 37.125 MHz, 74.25 MHz
INCK clock duty	_	45.0	50.0	55.0	%	Define with 0.5 x OV _{DD}
INCK Rise time	Tr_inck	_	_	5	ns	20 % to 80 %
INCK Fall time	Tf_inck	_	_	5	ns	80 % to 20 %

^{*}The INCK fluctuation affects the frame rate.

XVS / XHS Input Characteristics In Slave Mode (XMASTER pin = High)



Item	Symbol	Min.	Тур.	Max.	Unit	Remarks
XHS Low level pulse width	t _{WLXHS}	4 / f _{INCK}	l		ns	
XHS High level pulse width	twhxhs	4 / f _{INCK}		_	ns	
XVS - XHS fall width	t _{HFDLY}	1 / f _{INCK}	_	_	ns	
XHS - XVS rise width	t _{VRDLY}	1 / f _{INCK}	_	_	ns	
XVS Rise time	Tr_xvs	_	_	5	ns	20 % to 80 %
XVS Fall time	Tf_xvs	_	_	5	ns	80 % to 20 %
XHS Rise time	Tr_xhs	_	_	5	ns	20 % to 80 %
XHS Fall time	Tf_xhs	_	_	5	ns	80 % to 20 %

XVS / XHS Input Characteristics In Master Mode (XMASTER pin = Low)

^{*} XVS and XHS cannot be used for the sync signal to pixels.

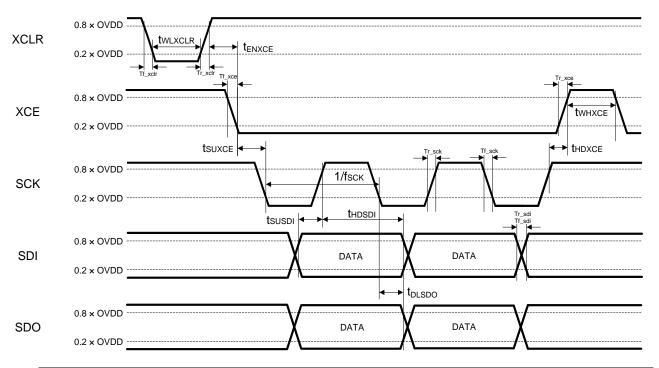
Be sure to detect sync code to detect the start of effective pixels in 1 line.

For the output waveforms in master mode, see the item of "Slave Mode and Master Mode"



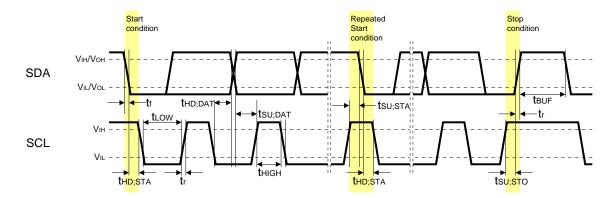
Serial Communication

4-wire



Item	Symbol	Min.	Тур.	Max.	Unit	Remarks
SCK clock frequency	f _{SCK}	_	ı	13.5	MHz	
XCLR Low level pulse width	t _{WLXCLR}	4 / f _{INCK}	1	_	ns	
XCE effective margin	t _{ENXCE}	20	ı		μs	
XCE input set-up time	t _{SUXCE}	20	1	_	ns	
XCE input hold time	t _{HDXCE}	20	ı	_	ns	
XCE High level pulse width	t _{WHXCE}	20		_	ns	
SDI input set-up time	t _{SUSDI}	10	ı		ns	
SDI input hold time	t _{HDSDI}	10	_	_	ns	
SDO output delay time	t _{DLSDO}	0		25	ns	Output load capacitance: 20 pF
XCLR Rise time	Tr_xclr	_	ı	5	ns	20 % to 80 %
XCLR Fall time	Tf_xclr	_	ı	5	ns	80 % to 20 %
XCE Rise time	Tr_xce	_	ı	5	ns	20 % to 80 %
XCE Fall time	Tf_xce	_		5	ns	80 % to 20 %
SCK Rise time	Tr_sck	_	ı	5	ns	20 % to 80 %
SCK Fall time	Tf_sck	_		5	ns	80 % to 20 %
SDI Rise time	Tr_sdi	_	_	5	ns	20 % to 80 %
SDI Fall time	Tf_sdi	_	_	5	ns	80 % to 20 %

 I^2C



I²C Specification

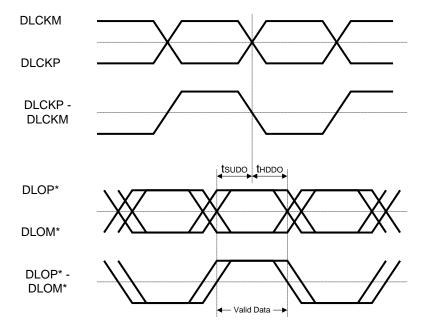
Item	Symbol	Min.	Тур.	Max.	Unit	条件
Low level input voltage	VIL	-0.3	_	0.3 × OV _{DD}	V	
High level input voltage	VIH	$0.7 \times OV_{DD}$	_	1.9	V	
Low level input voltage	VOL	0	_	0.2 × OV _{DD}	V	OVDD < 2 V, Sink 3 mA
High level input voltage	VOH	$0.8 \times OV_{DD}$	_	_	V	
Output fall time	tof	_		250	ns	Load 10 pF – 400 pF, 0.7 × OV _{DD} – 0.3 × OV _{DD}
Input current	li	-10	_	10	μΑ	$0.1 \times OV_{DD} - 0.9 \times OV_{DD}$
Capacitance for SCK (SCL) /SDI (SDA)	Ci	_	_	10	pF	

I²C AC Characteristics

Item	Symbol	Min.	Тур.	Max.	Unit
SCL clock frequency	f _{SCL}	0	_	400	kHz
Hold time (Start Condition)	t _{HD;STA}	0.6	_	_	μs
Low period of the SCL clock	t _{LOW}	1.3		1	μs
High period of the SCL clock	t _{HIGH}	0.6		1	μs
Set-up time (Repeated Start Condition)	t _{SU;STA}	0.6	_	_	μs
Data hold time	t _{HD;DAT}	0		0.9	μs
Data set-up time	t _{SU;DAT}	100		1	ns
Rise time of both SDA and SCL signals	t _r	_	l	300	ns
Fall time of both SDA and SCL signals	t _f			300	ns
Set-up time (Stop Condition)	t _{SU;STO}	0.6		1	μs
Bus free time between a STOP and START Condition	t _{BUF}	1.3	_	_	μs

DLCKP/DLCKM, DLOP/DLOM

Low Voltage LVDS DDR Output



(Output load capacitance: 8 pF)

Item	Symbol	Min.	Тур.	Max.	Unit	Remarks
DLCKP/DLCKM clock duty	_	40	50	60	%	DLCK = 297 MHz (Max.)
DLO set-up time	t _{SUDO}	400	_	_	ps	Data Rate 297 MHz DDR
DLO hold time	t _{HDDO}	400	_	_	ps	Data Rate 297 MHz DDR

I/O Equivalent Circuit Diagram

 $\hfill \square$: External pin

Symbol	Equivalent circuit	Symbol	Equivalent circuit
OMODE TENABLE	Digital input	XVS XHS	Digital I/O
XMASTER XCE	VDDM Digital input	SDO TOUT	Digital NO
XCLR INCK	Digital input	XTRIG	Digital Input
SDI SCK	Digital input	VRLFR VRLST	Analog I/O
VLOADLM VBGR TAMON	Analog input	DLOPX DLONX DLCKP DLCKM	VDDM VDDM DLOPX DLCKP WDDM DLOMX DLCKM
DMOPx DMOMx DMCKP DMCKM	VDDL VDDL DMOPx DMCKP VDDL DMOMX DMCKM		

Spectral Sensitivity Characteristics

(Excludes lens characteristics and light source characteristics.)

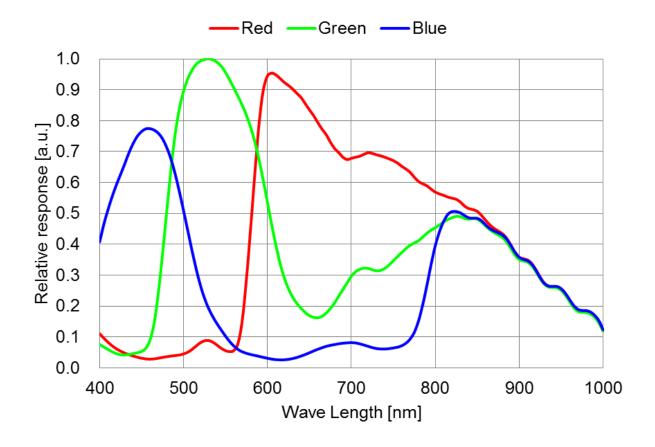


Image Sensor Characteristics

 $(AV_{DD} = 2.9 \text{ V}, OV_{DD} = 1.8 \text{ V}, DV_{DD} = 1.2 \text{ V}, Tj = 60 ^{\circ}C, All-pixel scan mode, 12 bit 30 frame/s, Gain: 0 dB)$

Item		Symbol	Min.	Тур.	Max.	Unit	Measurement method	Remarks	
G sensitivity		8	6593 (1105)	7757 (1300)	_	Digit (mV)	1	1/30 s storage 12 bit converted value HCG mode	
Sensitivity	R/G	RG	0.45	_	0.60	_	2	_	
ratio	B/G	BG	0.32	_	0.47	_	2	_	
Saturation sign	nal	Vsat	3854 (646)	_	_	Digit (mV)	3	12 bit converted value LCG mode	
Vertical line		VL	_	_	90	μV	4	12 bit converted value LCG mode	
Conversion efficiency ratio		Rcg	_	2	_	_	_	HCG mode / LCG mode	

Note)

- 1. Converted value into mV using 1Digit = 0.1676 mV for 12-bit output and 1Digit = 0.6702 mV for 10-bit output.
- 2. The video signal shading is the measured value in the wafer status (including color filter) and does not include characteristics of the seal glass.
- 3. The characteristics above apply to effective pixel area that is shown below.

Zone Definition

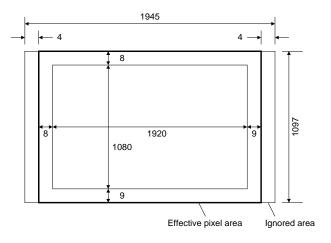


Image Sensor Characteristics Measurement Method

Measurement Conditions

1. In the following measurements, the device drive conditions are at the typical values of the bias conditions and clock voltage conditions.

2. In the following measurements, spot pixels are excluded and, unless otherwise specified, the optical black (OB) level is used as the reference for the signal output, which is taken as the value of the Gr / Gb channel signal output or the R / B channel signal output of the measurement system.

Color Coding of Physical Pixel Array

The primary color filters of this image sensor are arranged in the layout shown in the figure below. Gr and Gb represent the G signal on the same line as the R and B signals, respectively. The Gb signal and B signal lines and the R signal and Gr signal lines are output successively.

Gb	В	Gb	В
R	Gr	R	Gr
Gb	В	Gb	В
R	Gr	R	Gr

Color Coding Diagram

Definition of standard imaging conditions

Standard imaging condition I:

Use a pattern box (luminance: 706 cd/m², color temperature of 3200 K halogen source) as a subject. (Pattern for evaluation is not applicable.) Use a testing standard lens with CM500S (t = 1.0 mm) as an IR cut filter and image at F5.6. The luminous intensity to the sensor receiving surface at this point is defined as the standard sensitivity testing luminous intensity.

◆ Standard imaging condition II:

Image a light source (color temperature of 3200 K) with a uniformity of brightness within 2 % at all angles. Use a testing standard lens with CM500S (t = 1.0 mm) as an IR cut filter. The luminous intensity is adjusted to the value indicated in each testing item by the lens diaphragm.

◆ Standard imaging condition III:

Image a light source (color temperature of 3200 K) with a uniformity of brightness within 2 % at all angles. Use a testing standard lens (exit pupil distance - 30 mm) with CM500S (t = 1.0 mm) as an IR cut filter. The luminous intensity is adjusted to the value indicated in each testing item by the lens diaphragm.

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Measurement Method

1. Sensitivity

Set the measurement condition to the standard imaging condition I. After setting the electronic shutter mode with a shutter speed of 1/100 s, measure the Gr and Gb signal outputs (VGr, VGb) at the center of the screen, and substitute the values into the following formula.

$$Sg = (VGr + VGb) / 2 \times 100/30 [mV]$$

2. Sensitivity ratio

Set the measurement condition to the standard imaging condition II. After adjusting the average value of the Gr and Gb signal outputs to 650 mV, measure the R signal output (VR [mV]), the Gr and Gb signal outputs (VGr, VGb [mV]) and the B signal output (VB [mV]) at the center of the screen in frame readout mode, and substitute the values into the following formulas.

Saturation signa I

Set the measurement condition to the standard imaging condition II. After adjusting the luminous intensity to 20 times the intensity with the average value of the Gr and Gb signal outputs, 650 mV, measure the average values of the Gr, Gb, R and B signal outputs.

4. Vertical Line

With the device junction temperature of 60 $^{\circ}$ C and the device in the light-obstructed state, calculates each average output of Gr, Gb, R and B on respective columns. Calculates maximum value of difference with adjacent column on the same color (VL [μ V]).

Setting Registers Using Serial Communication

This sensor can write and read the setting values of the various registers shown in the Register Map by 4-wire serial communication and I^2C communication. See the Register Map for the addresses and setting values to be set. Because the two communication systems are judged at the first communication, once they are judged, the communication cannot be switched until sensor reset. The pin for 4-wire serial communication and I^2C communication is shared, so the external pin XCE must be fixed to power supply side when using I^2C communication.

Description of Setting Registers (4-wire)

The serial data input order is LSB-first transfer. The table below shows the various data types and descriptions.

Serial Data Transfer Order

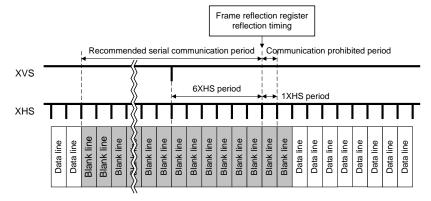
Chip ID	Start address	Data	Data	Data	
(8 bit)	(8 bit)	(8 bit)	(8 bit)	(8 bit)	(8 bit)

Type and Description

Type	Description
Chip ID	02h: Write to the Chip ID = 02h register 03h: Write to the Chip ID = 03h register 04h: Write to the Chip ID = 04h register 05h: Write to the Chip ID = 05h register 06h: Write to the Chip ID = 06h register 82h: Read from the Chip ID = 02h register 83h: Read from the Chip ID = 03h register 84h: Read from the Chip ID = 04h register 85h: Read from the Chip ID = 05h register 86h: Read from the Chip ID = 06h register
Address	Designate the address according to the Register Map. When using a communication method that designates continuous addresses, the address is automatically incremented from the previously transmitted address.
Data	Input the setting values according to the Register Map.

Register Communication Timing (4-wire)

Perform serial communication in sensor standby mode or within in the 6XHS period after the falling edge of XVS from the blanking line output start time after valid line of one frame is finished. For the registers marked "V" in the item of Reflection timing, when the communication is performed in the communication period shown in the figure below they are reflected by frame reflection timing. For the registers noted "Immediately" in the item of Reflection timing, the settings are reflected when the communication is performed. (For the immediate reflection registers other than STANDBY, REGHOLD, XMSTA, SW_RESET, XVSOUTSEL [1:0] and XHSOUTSEL [1:0], set them in sensor standby state.)



Register Write and Read (4-wire)

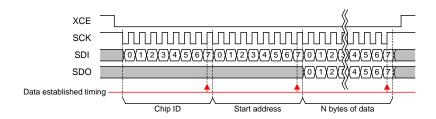
Follow the communication procedure below when writing registers.

- 1. Set XCE Low to enable the chip's communication function. Serial data input is executed using SCK and SDI.
- 2. Transmit data in sync with SCK 1 bit at a time from the LSB using SDI. Transfer SDI in sync with the falling edge of SCK. (The data is loaded at the rising edge of SCK.)
- 3. Input Chip ID (CID = 02h or 03h or 04h or 05h or 06h) to the first byte. If the Chip ID differs, subsequent data is ignored.
- 4. Input the start address to the second byte. The address is automatically incremented.
- 5. Input the data to the third and subsequent bytes. The data in the third byte is written to the register address designated by the second byte, and the register address is automatically incremented thereafter when writing the data for the fourth and subsequent bytes. Normal register data is loaded to the inside of the sensor and established in 8-bit units.
- 6. The register values starting from the register address designated by the second byte are output from the SDO pin. The register values before the write operation are output. The actual register values are the input data.
- 7. Set XCE High to end communication.

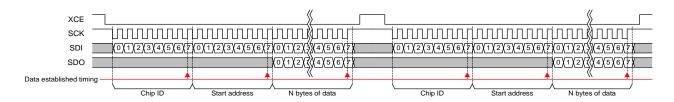
Follow the communication procedure below when reading registers.

- 1. Set XCE Low to enable the chip's communication function. Serial data input is executed using SCK and SDI.
- 2. Transmit data in sync with SCK 1 bit at a time from the LSB using SDI. Transfer SDI in sync with the falling edge of SCK. (The data is loaded at the rising edge of SCK.)
- 3. Input Chip ID (CID = 82h or 83h or 84h or 85h or 86h) to the first byte. If the Chip ID differs, subsequent data is ignored.
- 4. Input the start address to the second byte. The address is automatically incremented.
- 5. Input data to the third and subsequent bytes. Input dummy data in order to read the registers. The dummy data is not written to the registers. To read continuous data, input the necessary number of bytes of dummy data.
- 6. The register values starting from the register address designated by the second byte are output from the SDO pin. The input data is not written, so the actual register values are output.
- 7. Set XCE High to end communication.

Note) When writing data to multiple registers with discontinuous addresses, access to undesired registers can be avoided by repeating the above procedure multiple times.



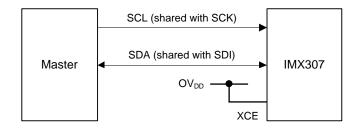
Serial Communication (Continuous Address)



Serial Communication (Discontinuous Address)

Description of Setting Registers (I²C)

The serial data input order is MSB-first transfer. The table below shows the various data types and descriptions.



Pin connection of serial communication

SLAVE Address

MSB							LSB
0	0	1	1	0	1	0	R/W

^{*} R/W is data direction bit

R/W

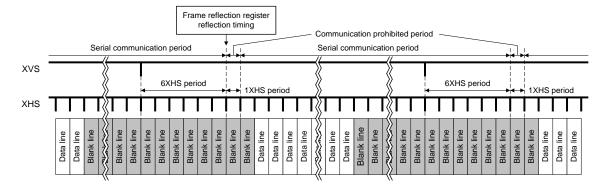
R / W bit	Data direction		
0	Write (Master → Sensor)		
1	Read (Sensor → Master)		

I²C pin description

Symbol	Pin No.	Remarks			
SCL (Common to SCK) G10		Serial clock input			
SDA (Common to SDI)	H10	Serial data communication			

Register Communication Timing (I²C)

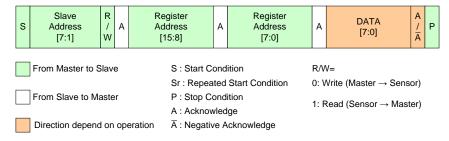
In I²C communication system, communication can be performed excluding during the period when communication is prohibited from the falling edge of XVS to 6H after (1H period). For the registers marked "V" in the item of Reflection timing, when the communication is performed in the communication period shown in the figure below they are reflected by frame reflection timing. For the registers noted "Immediately" in the item of Reflection timing, the settings are reflected when the communication is performed. (For the immediate reflection registers other than STANDBY, REGHOLD, XMSTA, SW_RESET, XVSOUTSEL [1:0] and XHSOUTSEL [1:0], set them in sensor standby state.) Using REG_HOLD function is recommended for register setting using I²C communication. For REG_HOLD function, see "Register Transmission Setting" in "Description of Functions".



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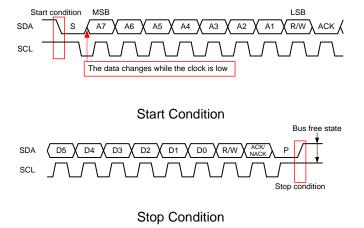
Communication Protocol

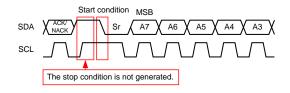
I²C serial communication supports a 16-bit register address and 8-bit data message type.



Communication Protocol

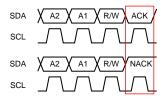
Data is transferred serially, MSB first in 8-bit units. After each data byte is transferred, A (Acknowledge) / \overline{A} (Negative Acknowledge) is transferred. Data (SDA) is transferred at the clock (SDL) cycle. SDA can change only while SCL is Low, so the SDA value must be held while SCL is High. The Start condition is defined by SDA changing from High to Low while SCL is High. When the Stop condition is not generated in the previous communication phase and Start condition for the next communication is generated, that Start condition is recognized as a Repeated Start condition.





Repeated Start Condition

After transfer of each data byte, the Master or the sensor transmits an Acknowledge / Negative Acknowledge and release (does not drive) SDA. When Negative Acknowledge is generated, the Master must immediately generate the Stop Condition and end the communication.



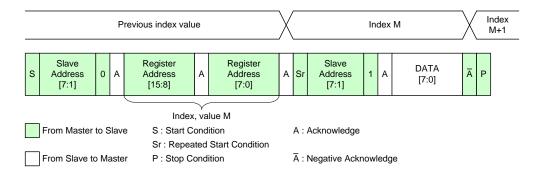
Acknowledge and Negative Acknowledge

Register Write and Read (I²C)

This sensor corresponds to four reed modes and the two write modes.

Single Read from Random Location

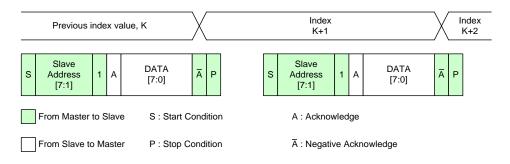
The sensor has an index function that indicates which address it is focusing on. In reading the data at an optional single address, the Master must set the index value to the address to be read. For this purpose it performs dummy write operation up to the register address. The upper level of the figure below shows the sensor internal index value, and the lower level of the figure shows the SDA I/O data flow. The Master sets the sensor index value to M by designating the sensor slave address with a write request, then designating the address (M). Then, the Master generates the start condition. The Start Condition is generated without generating the Stop Condition, so it becomes the Repeated Start Condition. Next, when the Master sends the slave address with a read request, the sensor outputs an Acknowledge immediately followed by the index address data on SDA. After the Master receives the data, it generates a Negative Acknowledge and the Stop Condition to end the communication



Single Read from Random Location

Single Read from Current Location

After the slave address is transmitted by a write request, that address is designated by the next communication and the index holds that value. In addition, when data read/write is performed, the index is incremented by the subsequent Acknowledge/Negative Acknowledge timing. When the index value is known to indicate the address to be read, sending the slave address with a read request allows the data to be read immediately after Acknowledge. After receiving the data, the Master generates a Negative Acknowledge and the Stop Condition to end the communication, but the index value is incremented, so the data at the next address can be read by sending the slave address with a read request.

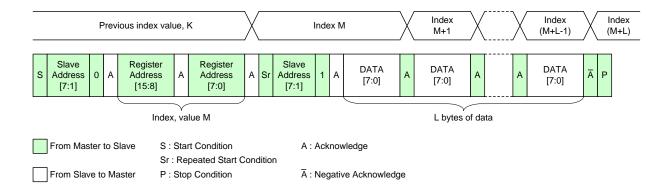


Single Read from Current Location



Sequential Read Starting from Random Location

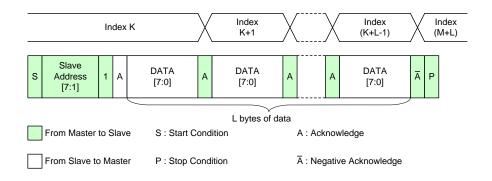
In reading data sequentially, which is starting from an optional address, the Master must set the index value to the start of the addresses to be read. For this purpose, dummy write operation includes the register address setting. The Master sets the sensor index value to M by designating the sensor slave address with a read request, then designating the address (M). Then, the Master generates the Repeated Start Condition. Next, when the Master sends the slave address with a read request, the sensor outputs an Acknowledge followed immediately by the index address data on SDA. When the Master outputs an Acknowledge after it receives the data, the index value inside the sensor is incremented and the data at the next address is output on SDA. This allows the Master to read data sequentially. After reading the necessary data, the Master generates a Negative Acknowledge and the Stop Condition to end the communication.



Sequential Read Starting from Random Location

Sequential Read Starting from Current Location

When the index value is known to indicate the address to be read, sending the slave address with a read request allows the data to be read immediately after the Acknowledge. When the Master outputs an Acknowledge after it receives the data, the index value inside the sensor is incremented and the data at the next address is output on SDA. This allows the Master to read data sequentially. After reading the necessary data, the Master generates a Negative Acknowledge and the Stop Condition to end the communication.

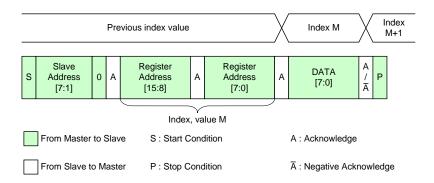


Sequential Read Starting from Current Location



Single Write to Random Location

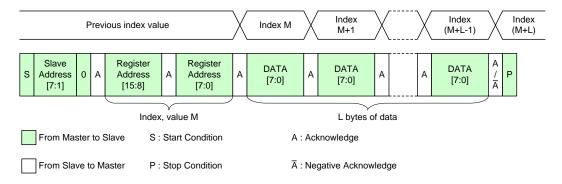
The Master sets the sensor index value to M by designating the sensor slave address with a write request, and designating the address (M). After that the Master can write the value in the designated register by transmitting the data to be written. After writing the necessary data, the Master generates the Stop Condition to end the communication.



Single Write to Random Location

Sequential Write Starting from Random Location

The Master can write a value to register address M by designating the sensor slave address with a write request, designating the address (M), and then transmitting the data to be written. After the sensor receives the write data, it outputs an Acknowledge and at the same time increments the register address, so the Master can write to the next address simply by continuing to transmit data. After the Master writes the necessary number of bytes, it generates the Stop Condition to end the communication.



Sequential Write Starting from Random Location

Register Map

This sensor has a total of 1280 bytes (256×5) of registers, composed of registers with addresses 00h to FFh that correspond to Chip ID = 02h (write mode) / 82h (read mode), Chip ID = 03h (write mode) / 83h (read mode), Chip ID = 04h (write mode) / 84h (read mode), Chip ID = 05h (write mode) / 85h (read mode), and Chip ID = 06h (write mode) / 86h (read mode). Use the initial values for empty address. Some registers must be change from the initial values, so the sensor control side should be capable of setting 1280 bytes.

The values must be changed from the default value, so initial setting after reset is required after power-on. There are two different register reflection timing. Values are reflected immediately after writing to register noted as "Immediately", or at the frame reflection register reflection timing described in the item of "Register Communication Timing" in the section of "Setting Registers with Serial Communication" for registers noted as "V" in the Reflection timing column of the Register Map. For the immediate reflection registers other than belows, set them in sensor standby state.

STANDBY REGHOLD XMSTA SW_RESET XVSOUTSEL [1:0] XHSOUTSEL [1:0]

Do not perform communication to addresses not listed in the Register Map. Doing so may result in operation errors. However, other registers that requires communication to address not listed above may be added, so addresses up to FFh should be supported for CID = 02h, 03h, 04h, 05h and 06h. (In I^2 C communication, address; 3000h to 30FFh, 3100h to 31FFh, 3200h to 32FFh, 3300h to 33FFh, 3400h to 34FFh)

For the register that is writing " * " to the setting value in description (Indicated by red letter), change the value from the default value after the reset.

(1) Registers corresponding to Chip ID = 02h in Write mode. (Read: Chip ID = 82h)

Add	lress		Register	5			Reflection
4	I ² C	bit	name	Description	Ву	Ву	timing
4-wire	-				register	address	_
		0	STANDBY	Standby 0: Operating 1: Standby	1h		Immediately
		1		Fixed to "0h"	0h		_
		2		Fixed to "0h"	0h		_
00h	3000h	3		Fixed to "0h"	0h	01h	_
		4		Fixed to "0h"	0h		_
		5		Fixed to "0h"	0h		_
		6		Fixed to "0h"	0h		_
		7		Fixed to "0h"	By register address	_	
		0	REGHOLD	Register hold (Function not to update V reflection register) 0: Invalid 1: Valid			Immediately
		1		Fixed to "0h"	0h 0h 0h 0h 0h 0h 0h 0h 0h 1h 0h	_	
01h	3001h	2		Fixed to "0h"	0h	00h	_
		3		Fixed to "0h"	0h		_
		4		Fixed to "0h"	0h		_
		5		Fixed to "0h"	0h		_
		6		Fixed to "0h"	0h		_
		7		Fixed to "0h"	0h	-	_
		0	XMSTA	Setting of master mode operation 0: Master mode operation start 1: Master mode operation stop	1h		Immediately
		1		Fixed to "0h"	0h		_
02h	3002h	2		Fixed to "0h"	0h		_
0211	300211	3		Fixed to "0h"	0h	0111	_
		4		Fixed to "0h"	0h		_
		5		Fixed to "0h"	0h		_
		6		Fixed to "0h"	0h		_
		7		Fixed to "0h"	0h		_
		0	SW_RESET	Software reset 0: Operating 1: Reset	0h		Immediately
02h		1		Fixed to "0h"	0h		_
001	00001	2		Fixed to "0h"	0h	001-	_
03h	3003h	3		Fixed to "0h"	0h	UUN	_
		4		Fixed to "0h"	0h		_
		5		Fixed to "0h"		1	_
		6		Fixed to "0h"		1	_
		7		Fixed to "0h"		1	_
04h	3004h	[7:0]		Fixed to "10h"	10h	10h	_

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Address			Register		Default value after reset		Reflection
4-wire	I ² C	bit	name Description	Description	By register	By address	timing
05h	3005h	0	ADBIT	AD conversion bits setting 0: 10 bit, 1: 12 bit	1h	01h	V
		1	_	Fixed to "0h"	0h		_
		2	_	Fixed to "0h"	0h		_
		3	_	Fixed to "0h"	0h		_
		4	_	Fixed to "0h"	0h		_
		5	_	Fixed to "0h"	0h		_
		6	_	Fixed to "0h"	0h		_
		7	_	Fixed to "0h"	0h		_
06h	3006h	[7:0]	_	Fixed to "00h"	00h	00h	V
	3007h	0	VREVERSE	Vertical (V) direction readout inversion control 0: Normal, 1: Inverted	0h		V
		1	HREVERSE	Horizontal (H) direction readout inversion control 0: Normal, 1: Inverted	0h		V
07h		2	_	Fixed to "0h"	0h	00h	_
		3	_	Fixed to "0h"	0h		_
		4 5 6	WINMODE [2:0]	Window mode setting 0: Full HD1080p 1: HD720p 4: Window cropping from Full HD 1080p Others: Setting prohibited	Oh		V
		7	_	Fixed to "0h"	0h		_
08h	3008h	[7:0]	_	Fixed to "A0h"	A0h	A0h	_
09h	3009h	0	FRSEL [1:0]	Frame rate (Data rate) setting For details, see the register setting list in each operation mode.	1h		V
		2	_	Fixed to "0h"	0h		_
		3	_	Fixed to "0h"	0h		_
		4	FDG_SEL	Conversion gain switching 0: LCG Mode 1: HCG Mode	Oh Oh	V	
		5	_	Fixed to "0h"	0h		_
		6	_	Fixed to "0h"	0h		_
		7	_	Fixed to "0h"	0h		_

Address			Register		Default value after reset		Pofloction	
	e I ² C	bit	name	Description	By	By		
4-wire					register	address	unning	
		0		LSB	register	addicss		
0Ah	300Ah	1	BLKLEVEL [8:0]	Black level offset value setting	0F0h	F0h		
		2						
		3						
							V	
		5					V	
		6						
		7						
		0						
		1		MSB Fixed to "0h"	0h	00h		
	300Bh		_					
		2		Fixed to "0h"	0h		_	
0Bh		4	_	Fixed to "0h"	0h			
			_	Fixed to "0h"	0h			
		5	_	Fixed to "0h"	0h			
		6 7	_	Fixed to "0h"	0h			
0.01		/	_	Fixed to "0h"	0h			
0Ch	300Ch							
~	~	[7:0]	_	Reserved	_	_	_	
10h	3010h	f= 01		0-44- 110 A b 11	0.01-	0.01-		
11h	3011h	[7:0]	_	Set to "0Ah"	00h	00h	Immediately	
12h	3012h	[7.0]		D				
\sim 13h	~ 3013h	[7:0]	_	Reserved	_	_	_	
1311	301311			LCD				
14h	3014h	0	GAIN [7:0]	Gain setting (0.0 dB to 69.0 dB / 0.3 dB step)	00h	00h		
		1						
		2						
		3					V	
		4						
		5						
		6						
		7		MSB				
15h	3015h							
~	~	[7:0]	_	Reserved	_	_	_	
17h	3017h							

Add	dress	la ia	Register	Description		t value reset	Reflection
4-wire	I ² C	bit	name	Description	By register	By address	timing
		0		LSB	- 5		
		1					
		2					
18h	3018h	3				65h	
1011	301011	4				oon	
		5		W/h and a second			
		6		When sensor master mode vertical			
		7		span setting. (Number of operation lines count from 1)			
			VMAX [17:0]	For details, see the item of	0465h		V
		1	VIVIAX [17.0]	"Slave Mode and Master Mode"	040311		V
		2		in the section of			
19h	3019h	3		"Description of Various Functions"		04h	
1911	301911	4		Description of various randicine		0411	
		5					
		6					
		7					
		0					
		1		MSB			
		2	_	Fixed to "0h"	0h		_
1 A b	301Ah	3	_	Fixed to "0h"	0h	00h	_
1Ah		4	_	Fixed to "0h"	0h	OOH	_
		5	_	Fixed to "0h"	0h		_
		6	_	Fixed to "0h"	0h		_
		7	_	Fixed to "0h"	0h		_
1Bh	301Bh	[7:0]	_	Fixed to "00h"	00h	00h	_
		0		LSB			
		1					
		2					
1Ch	301Ch	3				98h	
1011	301011	4		\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\		3011	
		5		When sensor master mode			
		6		horizontal span setting. (Number of operation clocks count from 1)			
		7	HMAX [15:0]	For details, see the item of			V
		0		"Slave Mode and Master Mode	0898h		٧
		1		" in the section of "Description of			
		2		Various Functions"			
1Dh	301Dh	3				08h	
1011	301011	4				0011	
		5					
		6					
		7		MSB			
1Eh			_	Fixed to "B2h"	B2h	B2h	_
1Fh	301Fh	[7:0]	_	Fixed to "01h"	01h	01h	_

Add	Iress		Register		Defaul after	t value reset	Reflection
4-wire	I ² C	bit	name	Description	By register	By address	timing
20h	3020h	0 1 2 3 4 5		LSB		00h	
21h	3021h	7 0 1 2 3 4 5 6 7	SHS1 [17:0]	Storage time adjustment Designated in line units.	00000h	00h	V
22h	3022h	0 1 2 3 4 5 6		MSB Fixed to "0h"	Oh Oh Oh Oh Oh Oh	00h	
23h to	3023h to	[7:0] to	_	Reserved	—	_	_
39h 3Ah	3039h 303Ah	[7:0] 0 1 2 3 4 5 6	WINWV_OB [3:0]	LSB In window cropping mode Cropping size designation (Vertical direction effective OB) MSB Fixed to "0h" Fixed to "0h" Fixed to "0h"	Ch Oh Oh	0Ch	V
3Bh	303Bh	7 [7:0]		Fixed to "0h" Fixed to "00h"	0h 00h	00h	_
3Ch	303Ch	0 1 2 3 4 5 6	WINPV [10:0]	LSB In window cropping mode Designation of upper left coordinate for cropping position (Vertical position)	000h	00h	٧
3Dh	303Dh	0 1 2 3 4 5 6		MSB Fixed to "0h"	0h 0h 0h 0h	00h	



Add	lress		Register			t value reset	Reflection
4-wire	I ² C	name 0		Description	By register	By address	timing
3Eh	303Eh	1 2 3		LSB	3,3 3 3 3	49h	
JEII	303E11	4 5 6 7	WINWV [10:0]	In window cropping mode WINWV [10:0] Cropping size designation (Vertical direction			V
		0 1 2 3	_	MSB Fixed to "0h"	0h		
3Fh	303Fh	4 5 6	_ _ _	Fixed to "0h" Fixed to "0h" Fixed to "0h"	Oh Oh Oh	04h	_
		7 0 1	_	Fixed to "0h" LSB	0h		_
40h	3040h	4 5 WINPH [10:0]		In window cropping mode Designation of upper left coordinate for cropping position (horizontal position) Set to become the multiple of four	000h	00h	V
41h	3041h	0 1 2 3 4 5	- - -	MSB Fixed to "0h" Fixed to "0h" Fixed to "0h" Fixed to "0h"	Oh Oh Oh	00h	
		7	_	Fixed to "0h"	0h		_
42h	3042h	6 7	WINWH [10:0]	LSB In window cropping mode Cropping size designation (horizontal direction) Set to become the multiple of four	79Ch	9Ch	V
		1 2		MSB	Oh		
43h	3043h	3		Fixed to "0h" Fixed to "0h"	0h 0h	07h	
		5 6 7	_ _ _	Fixed to "0h" Fixed to "0h" Fixed to "0h"	Oh Oh Oh		_ _ _
44h to 45h	1 3044h [7:0] to to —		_	Reserved	_	_	-

IMX307LQR-C

Add	Iress		Register			t value reset	Reflection
	0	bit	_	Description	By	By	timing
4-wire	I ² C	name			register	address	uning
		0	ODBIT	Number of output bit setting 0: 10 bit, 1: 12 bit * In CSI-2 mode (OMODE = Low), Fixed to "1h".	1h	addicos	Immediately
		1	_	Fixed to "0h"	0h		_
		2	_	Fixed to "0h"	0h		_
		3	_	Fixed to "0h"	0h		_
46h	3046h	4		Output interface selection (In CSI-2, don't care. CSI-2 Interface will be selected by Chip ID: 06h register.)		E1h	
		6	OPORTSEL [3:0]	Dh: LVDS 2 ch Eh: LVDS 4 ch	Eh		Immediately
		7		Others: Setting prohibited			
47h	3047h	[7:0]	_	Fixed to "01h"	01h	01h	_
4711	304711	0	_	Fixed to "Oh"	0h	0111	
		1	_	Fixed to "0h"	0h		_
		2	_	Fixed to "0h"	0h		
		3	_	Fixed to "Oh"	0h		_
48h	3048h	4		XVS pulse width setting in master mode.	0	00h	
		4	XVSLNG [1:0]	(In slave mode, setting is invalid.)	0h		Immediately
		5		0: 1H, 1: 2H, 2: 4H, 3: 8H			Í
		6	_	Fixed to "0h"	0h		_
		7	_	Fixed to "0h"	0h		_
		0	_	Fixed to "0h"	0h		_
		1	_	Fixed to "0h"	0h		_
		2	_	Fixed to "0h"	0h		_
		3	_	Fixed to "1h"	1h		_
49h	3049h	4 5	XHSLNG [1:0]	XHS pulse width setting in master mode. (In slave mode, setting is invalid.) 0: Min. to 3: Max.	0h	08h	Immediately
		6	_	Fixed to "0h"	0h		_
		7	_	Fixed to "0h"	0h		_
4Ah	304Ah	[7:0]	_	Fixed to "00h"	00h	00h	_
		0	XVSOUTSEL [1:0]	XVS pin setting in master mode 0: Fixed to High 2: VSYNC output Others: Setting prohibited	0h		Immediately
4Bh	304Bh	2	XHSOUTSEL [1:0]	XHS pin setting in master mode 0: Fixed to High 2: HSYNC output Others: Setting prohibited	0h	00h	Immediately
		4	_	Fixed to "0h"	0h		_
		5	_	Fixed to "0h"	0h		_
		6	_	Fixed to "0h"	0h		_
		7	_	Fixed to "0h"	0h		_

Add	dress		Register			t value reset	Reflection
4-wire	I ² C	bit	name	Description	By register	Ву	timing
						address	
4Ch	304Ch	[7:0]					
to	to	to	_	Reserved	_	_	_
5Bh	305Bh	[7:0]					
5Ch	305Ch	[7:0]	INCKSEL1	The value is set according to INCK.	0Ch	0Ch	Immediately
5Dh	305Dh	[7:0]	INCKSEL2	The value is set according to INCK.	00h	00h	Immediately
5Eh	305Eh	[7:0]	INCKSEL3	The value is set according to INCK.	10h	10h	Immediately
5Fh	305Fh	[7:0]	INCKSEL4	The value is set according to INCK.	01h	01h	Immediately
60h	3060h	[7:0]					
to	to	to	_	Reserved	_	_	_
9Dh	309Dh	[7:0]					
9Eh	309Eh	[7:0]	_	Set to "4Ah"	5Ah	5Ah	Immediately
9Fh	309Fh	[7:0]	_	Set to "4Ah"	5Ah	5Ah	Immediately
A0h	30A0h	[7:0]					
to	to	to	_	Reserved	_	_	_
FFh	30FFh	[7:0]					

(2) Registers corresponding to Chip ID = 03h in Write mode. (Read: Chip ID = 83h)

Add	dress	h:t	Register	Description	Defaul after	t value reset	Reflection
4-wire	I ² C	bit	name	Description	By register	By address	timing
00h to 1Bh	3100h to 311Bh	to	_	Reserved	_	1	_
1Ch	311Ch	[7:0]	_	Set to "0Eh"	1Eh	1Eh	_
1Dh to 27h	311Dh to 3127h	to	_	Reserved	_	1	_
28h	3128h		_	Set to "04h"	05h	05h	_
29h			ADBIT1	The value is set according to AD conversion bits 10 bit: 1Dh 12 bit: 00h	1Dh	1Dh	_
2Ah to 3Ah	312Ah to 313Ah	to	_	Reserved	_	_	_
3Bh	313Bh		_	Set to "41h"	51h	51h	_
3Ch to	313Ch to		_	Reserved	_	_	_
5Dh	315Dh	[7:0]					
5Eh			INCKSEL5	The value is set according to INCK. INCK = 74.25 MHz: 1Bh INCK = 37.125 MHz: 1Ah	1Bh	1Bh	Immediately
5Fh to 63h	315Fh to 3163h	to	-	Reserved	_	-	-
64h	3164h	[7:0]	INCKSEL6	The value is set according to INCK. INCK = 74.25 MHz: 1Bh INCK = 37.125 MHz: 1Ah	1Bh	1Bh	Immediately
65h to 7Bh	3165h to 317Bh	to	_	Reserved	_	_	-
7Ch	317Ch	[7:0]	ADBIT2	The value is set according to AD conversion bits 10 bit: 12h 12 bit: 00h	12h	12h	_
7Dh to EBh	317Dh to 31EBh	to	_	Reserved	_	1	_
ECh	31ECh		ADBIT3	The value is set according to AD conversion bits 10 bit: 37h 12 bit: 0Eh	37h	37h	_
EDh to FFh	31EDh to 31FFh	to	_	Reserved	_	_	_

(3) Registers corresponding to Chip ID = 04h in Write mode. (Read: Chip ID = 84h)

Add	Address		Register	Description	Default value after reset		Reflection
4-wire	I ² C	bit	name	Description	By register	By address	timing
00h	3200h	[7:0]					
to	to	to	_	Reserved	_	_	_
FFh	32FFh	[7:0]					

(4) Registers corresponding to Chip ID = 05h in Write mode. (Read: Chip ID = 85h)

Add	Address		Register	Description	Default value after reset		Reflection
4-wire	I ² C	bit	name	Description	By register	By address	timing
00h	3300h	[7:0]					
to	to	to	_	Reserved	_		_
FFh	33FFh	[7:0]					

(5) Registers corresponding to Chip ID = 06h in Write mode. (Read: Chip ID = 86h) * These registers are set in CSI-2 interface only.

Add	dress				Defaul	t value	
Add		bit	Register	Description		reset	Reflection
4-wire	I ² C	Dit	name	Beschpton	By register	By address	timing
00h	3400h	[7:0]					
to	to	to	_	Reserved	_	_	_
04h	3404h	[7:0]					
		0	_	Fixed to "0h"	0h		_
		1	_	Fixed to "0h"	0h		_
		2	_	Fixed to "0h"	0h		_
		3	_	Fixed to "0h"	0h		_
05h	3405h	4		* Refer to "Output signal		20h	
00	0 10011		REPETITION	Interfece Control"	2h	2011	Immediately
		5	[1:0]	Interface Control"	2.0		ininicalatory
				section.			
		6	_	Fixed to "0h"	0h		_
		7	_	Fixed to "0h"	0h		_
06h	3406h	[7:0]	_	Fixed to "00h"	00h	00h	_
		0	PHYSICAL_	Physically connect the Lane number	3h		Immediately
		1	LANE_NUM [1:0]				ininiculatory
		2	_	Fixed to "0h"	0h		_
07h	3407h	3	_	Fixed to "0h"	0h	03h	_
0711	0 10711	4	_	Fixed to "0h"	0h	0011	_
		5	_	Fixed to "0h"	0h		_
		6	_	Fixed to "0h"	0h		_
		7	_	Fixed to "0h"	0h		_
08h	3408h	[7:0]					
to	to	to	_	Reserved	_	_	_
13h	3413h						
		0		LSB			
		1					
		2	OPB_SIZE_V	Vertical (V) direction OB width setting. *	0Ah		Immediately
14h	3414h	3	[5:0]	Refer to each operating setting.		0Ah	,
		4					
		5		MSB			
		6	_	Fixed to "0h"	0h		
		7	_	Fixed to "0h"	0h		
15h	3415h						
to	to	to	_	Reserved	_	_	_
17h	3417h	[7:0]		LSB			
		0		LSB			
		1					
		2					
18h	3418h	3				49h	
		4		Vertical (V) direction effective			
		5	Y_OUT_SIZE	nivel width eatting	04406		lan an a di atali.
		6 7	[12:0]	pixel width setting.	0449h		Immediately
				* Refer to each operating setting.			
		0					
		1					
		2					
19h	3419h	3		MSB		04h	
		5		Fixed to "0h"	0h	-	
			_	Fixed to "0h"	Oh	-	_
		6	_			-	_
		7		Fixed to "0h"	0h		_



Add	dress	h.:4	Register	Description		t value reset	Reflection
4-wire	I ² C	bit	name	Description	By register	By address	timing
1Ah to 40h	341Ah to 3440h	to	-	Reserved	ı	1	I
41h	3441h	[7:0]	CSI_DT_FMT	LSB		0Ch	
42h	3442h	[7:0]	[15:0]	RAW10: 0A0Ah / RAW12: 0C0Ch MSB	0C0Ch	0Ch	Immediately
43h	3443h	[1:0] [7:2]	CSI_LANE_ MODE [1:0]	Lane number setting 0: Setting prohibited, 1: 2Lane, 3: 4Lane 2: Setting prohibited Fixed to "00h"	3h 00h	03h	Immediately
44h	3444h	[7:0]		LSB Master clock frequency		40h	
45h	3445h	[7:0]	EXTCK_FREQ [15:0]	2520h: INCK = 37.125 MHz 4A40h: INCK = 74.25 MHz MSB	4A40h	4Ah	Immediately
46h	3446h	[7:0] 0	TCLKPOST[8:0]	Global timing setting	047h	47h	Lanca a Patalo
47h	3447h	[7:1]	_	Fixed to "00h"	00h	00h	Immediately
48h	3448h	[7:0] 0	THSZERO[8:0]	Global timing setting	01Fh	1Fh	Immediately
49h	3449h	[7:1]	_	Fixed to "00h"	00h	00h	illillediately
4Ah	344Ah	[7:0] 0	THSPREPARE [8:0]	Global timing setting	017h	17h	Immediately
4Bh	344Bh	[7:1]		Fixed to "00h"	00h	00h	Illinediately
4Ch	344Ch	[7:0] 0	TCLKTRAIL[8:0]	Global timing setting	00Fh	0Fh	Immediately
4Dh	344Dh	[7:1]	_	Fixed to "00h"	00h	00h	illinediately
4Eh	344Eh		THSTRAIL[8:0]	Global timing setting	017h	17h	Imama a di atali
4Fh	344Fh	0 [7:1]	_	Fixed to "00h"	00h	00h	Immediately
50h	3450h		TCLKZERO[8:0]	Global timing setting	047h	47h	
51h	3451h	0 [7:1]		Fixed to "00h"	00h	00h	Immediately
52h	3452h	[7:0]	TCLKPREPARE	Global timing setting	00Fh	0Fh	
53h	3453h	0 [7:1]	[8:0] —	Fixed to "00h"	00h	00h	Immediately



Add	Iress		Register		Defaul after	t value reset	Reflection
4-wire	I ² C	bit	name	Description	By register	By address	timing
54h	3454h	[7:0]	TLPX[8:0]	Global timing setting	00Fh	0Fh	
55h	3455h	0				00h	Immediately
		[7:1]	_	Fixed to "00h"	00h	0011	
56h	3456h						
to	to	to	_	Reserved	_	_	_
71h	3471h	[7:0]					
		0		LSB			
		1					
		2					
72h	3472h	3				9Ch	
		4		Horizontal (H) direction effective			
		5	X_OUT_SIZE	, ,			
		6	[12:0]	pixel width setting.	079Ch		Immediately
		7		* Refer to each operating setting.			
		0					
		1 2					
73h	3473h	3				07h	
		4		MSB			
		5	_	Fixed to "0h"	0h		_
		6	_	Fixed to "0h"	0h		_
		7		Fixed to "0h"	0h		
74h	3474h	[7:0]					
to	to	to	_	Reserved	_	_	_
7Fh	347Fh	[7:0]					
0.01	0.4001		11101/051 7	The value is set according to INCK.	0.01	0.01	
80h	80h 3480h		INCKSEL7	INCK = 74.25 MHz: 92h	92h	92h	Immediately
0.41	0.4041	r= 0.		INCK = 37.125 MHz: 49h			
81h	3481h	-		D			
to	to	to	_	Reserved	_	_	_
FFh	34FFh	[7:0]					

Readout Drive mode

The table below lists the operating modes available with this sensor. (N/A: Not supported mode)

			4.5	0	_		D	ata rate		
Window	Mode	INCK	AD conversion	Output bit width	Frame rate	Serial LVDS		CSI-2		
VVIIIGOV	Wiode	[MHz]		[bit]	[frame/s]	[Mbps	s/ch]	[Mbps/Lar	ne]	
			[bit]	[DII]	[IIdille/S]	2 ch	4 ch	2 Lane	4 Lane	
	All pival	37.125	10/12	10/12	30 / 25	445.5	222.75	445.5	222.75	
Full HD	All pixel	74.25	10/12	10/12	60 / 50	N/A	445.5	891	445.5	
1080p	Window	Window	37.125	10/12	10/12	*1	445.5	222.75	445.5	222.75
	cropping	74.25	10/12	10/12	*2	N/A	445.5	891	445.5	
UD720n	امينو ال	37.125	10/12	10/12	30	297	148.5	297	148.5	
HD720p	All-pixel	74.25	10/12	10/12	60	594	297	594	297	

^{*1:} FRSEL = 2h

^{*2:} FRSEL = 1h

			F		rding els	Total number of pixels			
Window	Mode	INCK [MHz]	Frame rate	Н	V	H [pi	H [pixels]		1H period [µs]
		[1411 12]	[frame/s]	[pixels]	[lines]	CSI-2 (10 bit)	CSI-2 (12 bit)	V [lines]	[μο]
			25			3168	2640		35.6
	All-pixel	37.125 74.25	30	1920	1080	2640	2200	1125	29.6
			50			3168	2640		17.8
Full HD			60			2640	2200		14.8
1080p	Window	37.125	*1	*3	*3	2640	2200	*4	29.6
	cropping	74.25	*2	ა	ა	2040	2200	4	14.8
			25			3168	2640		53.3
HD720p	All-nival	37.125	30	1280	720	2640	2200	750	44.4
110120p	All-pixel	74.25	50	1280	120	3168	2640	730	26.7
			60			2640	2200		22.2

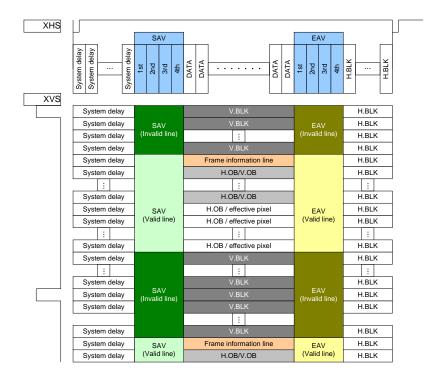
^{*1:} FRSEL = 2h

^{*2:} FRSEL = 1h

^{*3:} Arbitrary value that was designated to cropping area *4: Please refer to description of window cropping mode

Sync code (Serial LVDS output)

The sync code is added immediately before and after "dummy signal + OB signal + effective pixel data" and then output. The sync code is output in order of 1st, 2nd, 3rd and 4th. The fixed value is output for 1st to 3rd. (BLK: Blanking period)



Sync Code Output Timing

List of Sync Code

	Cura anda		code	2nd	code	3rd o	code	4th code	
	Sync code	10 bit	12 bit	10 bit	12 bit	10 bit	12 bit	10 bit	12 bit
SAV ((Valid line)	3FFh	FFFh	000h	000h	000h	000h	200h	800h
EAV (EAV (Valid line)		FFFh	000h	000h	000h	000h	274h	9D0h
SAV ((Invalid line)	3FFh	FFFh	000h	000h	000h	000h	2ACh	AB0h
EAV (EAV (Invalid line)		FFFh	000h	000h	000h	000h	2D8h	B60h

(Note 1) They are output to each channel seriously in MSB first when low-voltage LVDS serial. For details, see the item of "Signal output" and "Output pin setting".

Sync Code Output Timing

The sensor output signal passes through the internal circuits and is output with a latency time (system delay) relative to the horizontal sync signal. This system delay value is undefined for each line, so refer to the sync codes output from the sensor and perform synchronization.



Image Data Output Format (CSI-2 output)

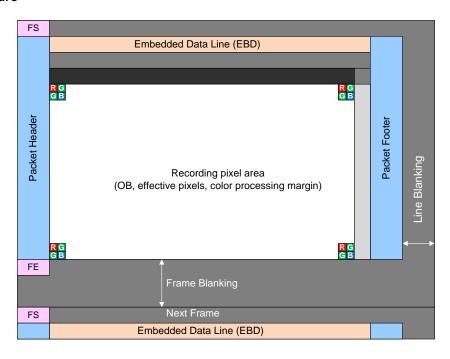
Frame Format

Each line of each image frame is output like the General Frame Format of CSI-2. The settings for each packet header are shown below.

DATA Type

Header [5:0]	Name	Setting register (I ² C)	Description		
00h	Frame Start Code	N/A	FS		
01h	Frame End Code	N/A	FE		
10h	NULL	N/A	Invalid data		
12h	Embedded Data	N/A	Embedded data		
2Bh	RAW10	Address: 41h, 42h (3441h, 3442h)	0A0Ah		
2Ch	RAW12	CSI_DT_FMT [15:0]	0C0Ch		
37h	OB Data	N/A	Vertical OB line data		

Frame Structure

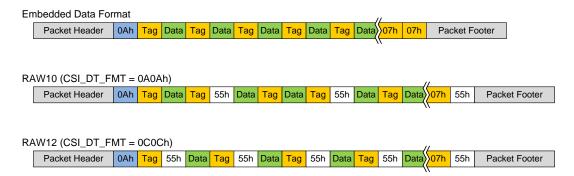


Frame Structure of CSI-2 output

IMX307LQR-C

Embedded Data Line

The Embedded data line is output in a line following the sync code FS.



The end of the address and the register value is determined according to the tags embedded in the data.

Embedded Data Line Tag

Tag	Data Byte Description
00h	Illegal Tag. If found treat as end of Data.
07h	End of Data.
AAh	CCI Register Index MSB [15:8]
A5h	CCI Register Index LSB [7:0]
5Ah	Auto increment the CCI index after the data byte – valid data Data byte contains valid CCI register data.
55h	Auto increment the CCI index after the data byte – null data A CCI register does not exist for the current CCI index. The data byte value is the 07h.
FFh	Illegal Tag. If found treat as end of Data.

Specific output examples are shown below. (4-wire: Chip ID = 05h)

	۸۵۸	ress		
Divol		EX]	Data Puta Description	Value
Pixel		=^] I ² C	Data Byte Description	Value
1.7	4-wire	10	ignored	
1-7	_	_	ignored	— 5Ah
8	0.41-	0.40 A I	REGHOLD value	
9	8Ah	348Ah	Laura and al	[0]*
10-21		_	Ignored	
22	041	0.4041	Frame count	5Ah
23	91h	3491h		[7:0]*
24-25	_	_	Ignored	
26	001	0.4001		5Ah
27	92h	3492h	Black level setting	[7:0]*
28	001	0.4001-	value	5Ah
29	93h	3493h		[15:8]*
30	0.41	0.40.41	Data format	5Ah
31	94h	3494h	RAW10: 0A0Ah	[7:0]*
32			RAW12: 0C0Ch	5Ah
33	95h	3495h		[15:8]*
34-73	_	_	Ignored	
74				5Ah
75	A8h	34A8h	Gain Setting Value	[7:0]*
76			J J	5Ah
77	A9h	34A9h		[15:8]*
78-85	_	_	Ignored	
86				5Ah
87	B1h	34B1h		[7:0]*
88			Shutter setting value	5Ah
89	B2h	34B2h	- committee of the comm	[15:8]*
90				5Ah
91	B3h	34B3h		[23:16]*
92-125	_	_	Ignored	_
126	_			5Ah
127	C9h	34C9h		[7:0]*
128			Vertical line value	5Ah
129	CAh	34CAh	(VMAX)	[15:8]*
130				5Ah
131	CBh	34CBh		[23:16]*
132				5Ah
133	CCh	34CCh	Horizontal clock value	[7:0]*
134			(HMAX)	5Ah
135	CDh	34CDh		[15:8]*
136-197	_	_	Ignored	_
198			Number of lane	5Ah
199	C8h	34C8h	14dilibol of latto	[1:0]*
200-230	_	_	ignored	_

^{*}The value that shown in Data Byte Description is output.

Image Data Output Format

All-pixel scan mode (Full HD 1080p)

List of Setting Register for LVDS serial output

Add	ress			Initial	LVDS	serial				
4-wire	I ² C	bit	Register Name	Value	2 ch	4 ch	備考			
Chip ID:					-					
05h	3005h	[0]	ADBIT	1h	0h /	′ 1h	0: 10 bit, 1: 12 bit			
		[0]	VREVERSE	0h	0h /	′ 1h	0: Normal, 1: Inverted			
07h	3007h	[1]	HREVERSE	0h	0h /	′ 1h	0: Normal, 1: Inverted			
		[6:4]	WINMODE	0h	0	h	Full HD 1080p			
		[4.0]	EDOEL	41.	2	h	30 / 25 [frame/s]			
09h	3009h	[1:0]	FRSEL	1h	N/A	1h	60 / 50 [frame/s]			
		[4]	FDG_SEL	0h	0h /	′ 1h	0: LCG mode, 1: HCG mode			
12h	3012h	[7:0]	_	F0h	64h		Initial setting			
13h	3013h	[7:0]	_	00h	00h		Initial setting			
18h	3018h	[7:0]								
19h	3019h	[7:0]	VMAX	465h	46	5h	25 /30 / 50 / 60 [frame/s]			
1Ah	301Ah	[1:0]								
1Ch	301Ch	[7:0]			1130h /	1/10h	1130h: 30[frame/s] /			
1011	301011	[7.0]	HMAX	0898h	113011/	14/1011	14A0h: 25[frame/s]			
1Dh	301Dh	[7:0]	I IIVIAA	003011	N/A	0898h /	0898h: 60[frame/s] /			
1011	30 1011	[7.0]			IV/A	0A50h	0A50h: 50[frame/s]			
46h	3046h	[1:0]	ODBIT	1h	0h /	1h	0: 10 bit, 1: 12 bit			
4011	304011	[7:4]	OPORTSEL	Eh	Dh Eh		I/F selection			
5Ch	305Ch	[7:0]	INCKSEL1	0Ch	0Ch	/18h				
5Dh	305Dh	[7:0]	INCKSEL2	00h	00h /	00h	Set according to INCK			
5Eh	305Eh	[7:0]	INCKSEL3	10h	10h /	20h	74.25 / 37.125 MHz			
5Fh	305Fh	[7:0]	INCKSEL4	01h	01h /	01h				
Chip ID =	= 03h									
29h	3129h	[7:0]	ADBIT1	1Dh	1Dh	00h	10 bit: 1Dh 12 bit: 00h			
5Eh	315Eh	[7:0]	INCKSEL5	1Bh	1Bh /	1Ah	INCK: 74.25 / 37.125 MHz			
64h	3164h	[7:0]	INCKSEL6	1Bh	1Bh /	1Ah	INCK: 74.25 / 37.125 MHz			
7Ch	317Ch	[7:0]	ADBIT2	12h	12h /	′ 00h	10 bit: 12h			
							12 bit: 00h			
ECh	31ECh	[7:0]	ADBIT3	37h	37h /	0Eh	10 bit: 37h 12 bit: 0Eh			
Chip ID =	= 04h									
00h	3200h	[7:0]								
~	~	~	Set register value	that des	cribed on	item "Reg	ister map".			
FFh	32FFh	[7:0]								
Chip ID =	= 05h									
00h	3300h	[7:0]								
~	~	~	Set register value	that des	cribed on	item "Reg	ister map".			
FFh	33FFh	[7:0]								
Chip ID =	= 06h									
00h	3400h	[7:0]								
~	~	~	Changing the value is not necessary.							
7Fh	347Fh	[7:0]		1						
80h	3480h	• •	INCKSEL7	92h	92h /	49h	INCK: 74.25 / 37.125 MHz			
81h	3481h	[7:0]								
~	~	~	Changing the valu	e is not	necessary	•0				
FFh	Fh 34FFh [7:0]									

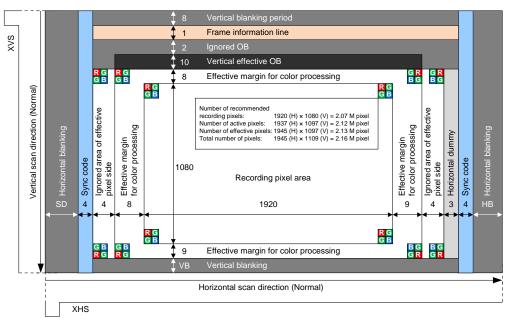


List of Setting Register for CSI-2 serial output

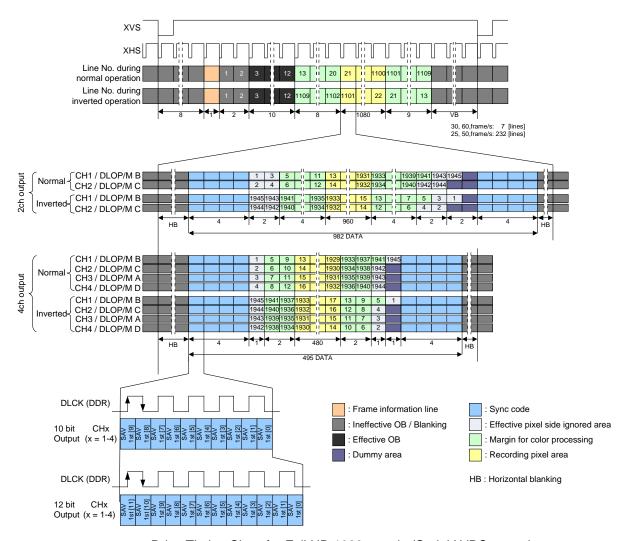
Register Name Part Par	
4-wire I ² C Name Value 30 / 25 [frame /s] 60 / 50 [frame /s] 30 / 25 [frame /s] 60 / 50 [frame /s] Chip ID: 02h 05h 3005h [0] ADBIT 1h 0h / 1h 0: 10 bit, 1: 12 bit 07h 3007h [0] VREVERSE 0h 0h / 1h 0: Normal, 1: Invertomental inverto	
[frame /s] [fr	
05h 3005h [0] ADBIT 1h 0h / 1h 0: 10 bit, 1: 12 bit 07h 3007h [0] VREVERSE 0h 0h / 1h 0: Normal, 1: Invertomental inv	
07h 3007h [0] VREVERSE 0h 0h / 1h 0: Normal, 1: Inverted to the control of t	
07h 3007h [1] HREVERSE 0h 0h / 1h 0: Normal, 1: Inverte	
[6:4] WINMODE 0h 0h Full HD 1080p	ed
[1:0] FRSEL 1h 2h 1h 2h 1h	
09h 3009h [4] FDG_SEL 0h 0h / 1h 0: LCG mode,	
1: HCG mode	
12h 3012h [7:0] — F0h 64h Initial setting	
13h 3013h [7:0] — 00h 00h Initial setting	
18h 3018h [7:0] 25 /30 / 50 / 60	
19h 3019h [7:0] VMAX 465h 465h [frame/s]	
1Ah 301Ah [1:0]	
1Ch 301Ch [7:0] HMAX 0898h 1130h / 0898h / 1130h / 0898h / 30 / 60[frame / s] /	
1Dh 301Dh [7:0] 14A0h 0A50h 14A0h 0A50h 25 / 50[frame / s]	
46h 3046h [1:0] ODBIT 1h 1h In CSI-2, fixed to "1	
[7:4] OPORTSEL Eh 0h In CSI-2, fixed to "0	h".
5Ch 305Ch [7:0] INCKSEL1 0Ch 0Ch / 18h	
5Dh 305Dh [7:0] INCKSEL2 00h 03h / 03h Set according to IN	
5Eh 305Eh [7:0] INCKSEL3 10h 10h / 20h 74.25 / 37.125 MHz	-
5Fh 305Fh [7:0] INCKSEL4 01h 01h / 01h	
Chip ID: 03h	
29h 3129h [7:0] ADBIT1 1Dh 1Dh / 00h 10 bit: 1Dh 10 bit: 1	
12 bit: 00h	
5Eh 315Eh [7:0] INCKSEL5 1Bh 1Bh / 1Ah Set according to IN	
/4.25 / 3/.125 MHz	
64h 3164h [7:0] INCKSEL6 1Bh 1Bh 1Bh 1Ah	
74.25 / 37.125 MHz	<u> </u>
7Ch 317Ch [7:0] ADBIT2 12h 12h / 00h 10 bit: 12h 12h / 00h	
12 bit: 00h	
ECh 31ECh [7:0] ADBIT3 37h 37h / 0Eh 10 bit: 37h 12 bit: 0Eh	
Chip ID: 04h 00h 3200h [7:0]	
00h 3200h [7:0]	
FFh 32FFh [7:0]	
Chip ID: 05h	
00h 3300h [7:0]	
~ ~ Set register value that described on item "Register map".	
FFh 33FFh [7:0]	



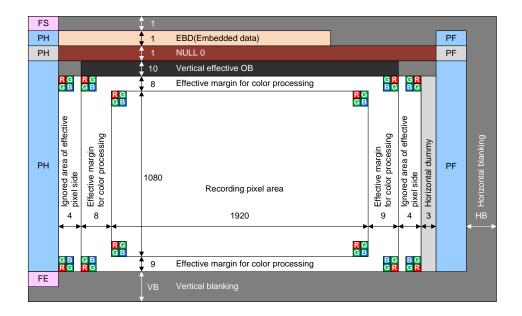
۸ ما ما						CSI-2	serial		
Add	ress	bit	Register	Initial	2 la	ane	4 la	ane	Remarks
4-wire	I ² C	DIL	Name	Value	30 / 25	60 / 50	30 / 25	60 / 50	Remarks
4-WITE	10				[frame /s]	[frame /s]	[frame /s]	[frame /s]	
Chip ID	= 06h								
	,			ta rate	445.5	891	222.75	445.5	[Mbps / Lane]
05h	3405h	[5:4]	REPETITION	2h	1h	0h	2h	1h	
07h	3407h	[1:0]	PHYSICAL_ LANE_NUM	3h	1	h			
14h	3414h	[5:0]	OPB_SIZE_V	Ah		Α	h		
18h	3418h	[7:0]	Y_OUT_SIZE	0449h		044	10h		
19h	3419h	[4:0]	1_001_3IZE	044911		044	+911		
41h	3441h	[7:0]	CSI_DT_FMT	0C0Ch		04046	0C0Ch		0A0Ah: RAW10 /
42h	3442h	[7:0]	CSI_DT_FWIT	OCOCII		UAUAII /	UCUCII		0C0Ch: RAW12
43h	3443h	[1:0]	CSI_LANE_ MODE	3h	1	h	3	h	
44h	3444h	[7:0]	5)/T01/ 5050			37.125 MI			
45h	3445h	[7:0]	EXTCK_FREQ	4A40h		74.25 MH	Set according to INCK		
46h	3446h	[7:0]	TOLLIDOOT	0.471	0.571	0771	0.471	0.571	0. 1. 1.1
47h	3447h	[0]	TCLKPOST	047h	057h	077h	047h	057h	Global timing
48h	3448h	[7:0]	T. 107ED 0	0.4.51	-1 0071	007h	01Fb	007	01.1.17
49h	3449h	[0]	THSZERO	01Fh	037h	067h	01Fh	037h	Global timing
4Ah	344Ah	[7:0]	TUCDDEDADE	0475	0456	0.475	0476	0456	Clabal timina
4Bh	344Bh	[0]	THSPREPARE	017h	01Fh	047h	017h	01Fh	Global timing
4Ch	344Ch	[7:0]	TOLKTDAII	00Fh	01Fh	027h	00 . Fb	01Fh	Clobal timing
4Dh	344Dh	[0]	TCLKTRAIL	OUFN	UTFII	037h	00Fh	OIFII	Global timing
4Eh	344Eh	[7:0]	THSTRAIL	017h	01Fh	03Fh	017h	01Fh	Clohal timing
4Fh	344Fh	[0]	THOTKAIL	01711	UTFII	USFII	01711	UTFII	Global timing
50h	3450h	[7:0]	TCLKZERO	047h	077h	0FFh	047h	077h	Global timing
51h	3451h	[0]	TOLNZERU	04/11	07711	VI-FII	04/11	07711	Global tilling
52h	3452h	[7:0]	TCLKPREPARE	00Fh	01Fh	03Fh	00Fh	01Fh	Global timing
53h	3453h	[0]	TOLKI KLEAKE	OUFTI	VIIII	UJITI	UUITII	UTFII	Clobal tilling
54h	3454h	[7:0]	TLPX	00Fh	017h	037h	00Fh	017h	Global timing
55h	3455h	[0]		OULII	01711	03/11	UUITII	01711	Clobal tilling
72h	3472h	[7:0]	X OUT SIZE	079Ch		079			
73h	3473h	[4:0]	1/_001_31/E	079011					
80h	3480h	[7:0]	INCKSEL7	92h		37.125 N 74.25 M	//Hz :49h Hz :92h		Set according to INCK



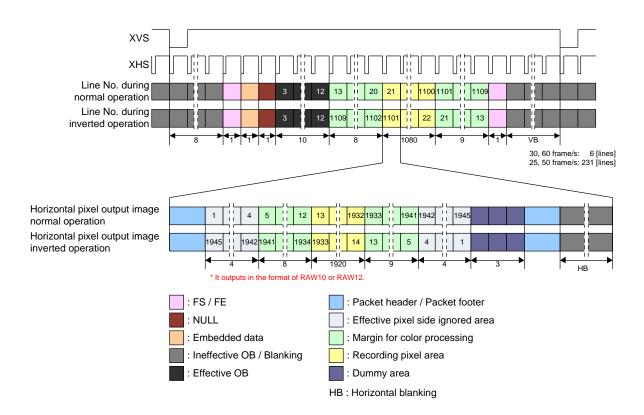
Pixel Array Image Drawing in Full HD 1080p mode (Serial LVDS output)



Drive Timing Chart for Full HD 1080p mode (Serial LVDS output)



Pixel Array Image Drawing in Full HD 1080p mode (CSI-2 serial output)



Drive Timing Chart for Full HD 1080p mode (CSI-2 serial output)

Window Cropping Mode

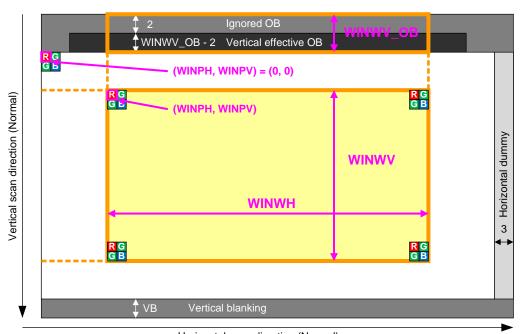
Sensor signals are cut out and read out in arbitrary positions.

Cropping position is set, regarding effective pixel start position as origin (0, 0) in all pixel scan mode. Cropping is available from all-pixel scan mode and vertical, horizontal period and frame rate are fixed to the value for this mode. Pixels cropped by horizontal cropping setting are output with left justified and that extends the horizontal blanking period.

Window cropping image is shown in the figure below.

Cropping position is set, regarding effective pixel start position as origin (0, 0) in all pixel scan mode.

Only vertical width can be set for OB (horizontal width is the same as the Window cropping width).



Horizontal scan direction (Normal)

Image Drawing of Window Cropping Mode

Restrictions on Window cropping mode

The register settings should satisfy following conditions:

WINPH + WINWH ≤ 1944 368 ≤ WINWH Set WINPH and WINWH to a multiple of 4.

V_{TTL} (Number of lines per frame or VMAX) ≥ WINWV_OB + WINWV + 13

However, $6 \le WINWV_OB \le 12$ WINPV + WINWV ≤ 1096 $304 \le WINWV$ OB_SIZE_V = WINWV_OB - 2 (In CSI-2 output) Y_OUT_SIZE = WINWV (In CSI-2 output)

Frame rate on Window cropping mode
Frame rate [frame/s] = 1 / (V_{TTL} × (1H period))

1H period (unit: $[\mu s]$): Fix 1H time in a mode before cropping and calculate it by the value of "Number of INCK in 1H" in the table of "Operating Mode" and "List of Operation Modes and Output Rates".



List of Setting Register for LVDS serial output

Δdd	ress										
4-wire	I ² C	bit	Register Name	Initial Value	LVDS 2 ch	4 ch	備考				
Chip ID:				value	2 011	7 011					
05h	3005h	[0]	ADBIT	1h	0h /	/ 1h	0: 10 bit, 1: 12 bit				
0011	300311	[0]	VREVERSE	0h	0h /		0: Normal, 1: Inverted				
07h	3007h		HREVERSE	0h	0h /		·				
0/11	300711	[1]					0: Normal, 1: Inverted				
		[6:4]	WINMODE	0h	4		Window cropping				
001	00001	[1:0]	FRSEL	1h	2						
09h	3009h				N/A	1h	2 1 2 2 1 1 1 1 2 2				
		[4]	FDG_SEL	0h	0h /		0: LCG mode, 1: HCG mode				
12h	3012h	[7:0]	_	F0h			Initial setting				
13h	3013h	[7:0]	_	00h	00)h	Initial setting				
18h	3018h	[7:0]									
19h	3019h	[7:0]	VMAX	465h	V _T	TL	See previous page.				
1Ah	301Ah	[1:0]									
1Ch	201Ch	[7:0]			1130h / 14A0h		1130h: 30[frame/s] /				
1Ch	301Ch	[7:0]	LINAAN	00001	113011/ 14A011		14A0h: 25[frame/s]				
451	00451	r= 01	HMAX	0898h	11/0	0898h /	0898h: 60[frame/s] /				
1Dh	301Dh	[7:0]			N/A		0A50h: 50[frame/s]				
		[1:0]	ODBIT	1h	0h /	′ 1h	0: 10 bit, 1: 12 bit				
46h	3046h		OPORTSEL	Eh			I/F selection				
5Ch	305Ch		INCKSEL1	0Ch	0Ch / 18h						
5Dh	305Dh		INCKSEL2	00h			Set according to INCK				
5Eh	305Eh		INCKSEL3	10h	10h /		74.25/37.125 MHz				
5Fh	305Fh	[7:0]	INCKSEL4	01h	01h		7 4.20/07.123 WITE				
Chip ID :		[7.0]	INONOLLY	0111	01117	OIII					
Chip iD .	- 0311			l			10 bit: 1Dh				
29h	3129h	[7:0]	ADBIT1	1Dh	1Dh	/ 00h	12 bit: 00h				
FFh	215Ch	[7,0]	INCKSEL5	1Dh	1Dh	/ 1 A b					
5Eh	315Eh			1Bh	1Bh /		INCK: 74.25 / 37.125 MHz				
64h	3164h	[7:0]	INCKSEL6	1Bh	1Bh /	TAN	INCK: 74.25 / 37.125 MHz				
7Ch	317Ch	[7:0]	ADBIT2	12h	12h /	00h	10 bit: 12h				
							12 bit: 00h				
ECh	31ECh	[7:0]	ADBIT3	37h	37h /	0Eh	10 bit: 37h				
							12 bit: 0Eh				
Chip ID :			I								
00h	3200h	[7:0]									
~	~	~	Set register value	that des	cribed on i	tem "Regi	ster map".				
FFh	32FFh	[7:0]									
Chip ID :			ı								
00h	3300h	[7:0]									
~	~	~	Set register value	that des	cribed on i	tem "Regi	ster map".。				
FFh	33FFh	[7:0]									
Chip ID :	= 06h										
00h	3400h	[7:0]									
~	~	~	Changing the valu	ie is not i	necessary.						
7Fh	347Fh	[7:0]									
80h	3480h	[7:0]	INCKSEL7	92h	92h /	49h	NCK: 74.25 / 37.125 MHz				
81h	3481h	[7:0]									
~	~	~	Changing the valu	ie is not i	necessary.						
FFh	34FFh	[7:0]									



List of Setting Register for CSI-2 serial output

						CSI-2	serial				
Add	ress	1. 24	Register	Initial	2 la	ne	4 la	ane	Remarks		
4 wire	I ² C	bit	Name	Value	*1	*2	*1	*2			
4-wire	10				[frame /s]	[frame /s]	[frame /s]	[frame /s]			
Chip ID): 02h										
05h	3005h	[0]	ADBIT	1h		0h	/ 1h		0: 10 bit, 1: 12 bit		
		[0]	VREVERSE	0h		0h	/ 1h		0: Normal, 1: Inverted		
07h	3007h	[1]	HREVERSE	0h		0h	/ 1h		0: Normal, 1: Inverted		
		[6:4]	WINMODE	0h		4	h		Window cropping		
		[1:0]	FRSEL	1h	2h	1h	2h	1h			
09h	3009h	[4]	FDG_SEL	0h		0h	/ 1h		0: LCG mode, 1: HCG mode		
12h	3012h	[7:0]	_	F0h		64	4h		Initial setting		
	3013h			00h		00	0h		Initial setting		
18h	3018h										
19h	3019h	[7:0]	VMAX	465h		V-	TTL		See previous page.		
1Ah	301Ah	[1:0]									
1Ch	301Bh	[7:0]		00001	1130h /	0898h /	465h: 30 / 60[frame / s] /				
1Dh	301Ch	[7:0]	HIMAX	0898h	14A0h 0A50h 14A0h 0A50h				546h: 25 / 50[frame / s]		
401-	0040	[1:0]	ODBIT	1h		1	In CSI-2, fixed to "1h".				
46h	3046n	[7:4]	OPORTSEL	Eh		0	In CSI-2, fixed to "0h".				
5Ch	305Ch	[7:0]	INCKSEL1	0Ch		0Ch					
5Dh	305Dh	[7:0]	INCKSEL2	00h		03h	/ 03h		Set according to INCK		
5Eh	305Eh	[7:0]	INCKSEL3	10h		10h	/ 20h		74.25/37.125 MHz		
5Fh	305Fh	[7:0]	INCKSEL4	01h		01h	/ 01h				
Chip ID	0 = 03h										
29h	3129h	[7:0]	ADBIT1	1Dh		1Dh	/ 00h		10 bit: 1Dh 12 bit: 00h		
5Eh	315Eh	[7:0]	INCKSEL5	1Bh		1Bh	/ 1Ah		Set according to INCK 74.25 / 37.125 MHz		
64h	3164h	[7:0]	INCKSEL6	1Bh		1Bh	/ 1Ah		Set according to INCK 74.25 / 37.125 MHz		
7Ch	317Ch	[7:0]	ADBIT2	12h		12h	/ 00h		10 bit: 12h 12 bit: 00h		
ECh	31ECh	[7:0]	ADBIT3	37h		37h	/ 0Eh		10 bit: 37h 12 bit: 0Eh		
Chip ID) = 04h		<u> </u>						I'Z DIL. ULII		
00h	3200h	[7:0]									
~	~	~	Set register value	e that de	scribed on ite	em "Registe	r map".				
FFh	32FFh	[7:0]									
Chip ID											
00h	3300h	[7:0]									
~	~	~	Set register value	that de	scribed on ite	em "Registe	r map".				
FFh	33FFh	[7:0]									



					CSI-2 serial				
Add	ress	bit	Register	Initial	2 la	ane	4 la	ane	Remarks
4-wire	I ² C	DIL	Name	Value	*1	*2	*1	*2	
4-wire	10				[frame /s]	[frame /s]	[frame /s]	[frame /s]	
Chip ID	0 = 06h								
				ta rate	445.5	891	222.75	445.5	[Mbps / Lane]
05h	3405h	[5:4]	REPETITION	2h	1h	0h	2h	1h	
07h	3407h	[1:0]	PHYSICAL_ LANE_NUM	3h	1	h			
14h	3414h	[5:0]	OPB_SIZE_V	Ah		Δ	۸h		
18h	3418h	[7:0]	Y_OUT_SIZE	0449h		04	49h		
19h	3419h	[4:0]	1_001_312L	044311		04	+311		
41h	3441h	[7:0]	CSI_DT_FMT	0C0Ch		ΛΔΛΔΗ	/ 0C0Ch		0A0Ah: RAW10 /
42h	3442h	[7:0]	OGI_DT_FWIT	OCOCII		UAUAII	, 000011		0C0Ch: RAW12
43h	3443h	[1:0]	CSI_LANE_ MODE	3h	1	h	3	h	
44h	3444h	[7:0]	EVTOK EDEO	4 4 4 0 1-		37.125 MI	Set according to INCK		
45h	3445h	[7:0]	EXTCK_FREQ	4A40h		74.25 MH	Cot according to INOIN		
46h	3446h	[7:0]	TOLKDOOT	0.475	0.E.7.b	0775	0.475	0575	Clabal timina
47h	3447h	[0]	TCLKPOST	047h	057h	077h	047h	057h	Global timing
48h	3448h	[7:0]	TUCZEDO	01Fh	027h	067h	0456	027h	Clobal timing
49h	3449h	[0]	THSZERO	01Fh	037h	067h	01Fh	037h	Global timing
4Ah	344Ah	[7:0]	THSPREPARE	017h	01Fh	047h	017h	01Fh	Global timing
4Bh	344Bh	[0]	THOFKLIAKL	01711	UTITI	04711	01711	UTFII	Global tilling
4Ch	344Ch	[7:0]	TCLKTRAIL	00Fh	01Fh	037h	00Fh	01Fh	Global timing
4Dh	344Dh	[0]	TOLKTRAIL	00111	UTITI	03711	00111	UTFII	Global tilling
4Eh	344Eh	[7:0]	THSTRAIL	017h	01Fh	03Fh	017h	01Fh	Global timing
4Fh	344Fh	[0]	THOTKAIL	01711	VIIII	UJITI	01711	UTFII	Clobal tilling
50h	3450h	[7:0]	TCLKZERO	047h	077h	0FFh	047h	077h	Global timing
51h	3451h	[0]	TOLKELKO	04/11	OTTI	OI FII	04/11	07711	Clobal tilling
52h	3452h	[7:0]	TCLKPREPARE	00Fh	01Fh	03Fh	00Fh	01Fh	Global timing
53h	3453h	[0]	TOLKI KLI AKL	301 11	01111	00111	00111	01111	Clobal tilling
54h	3454h	[7:0]	TLPX	00Fh	017h	037h	00Fh	017h	Global timing
55h	3455h	[0]	1217	00111	017h 037h 00Fh 017h				Clobal alling
72h	3472h	[7:0]	V OUT SIZE	07006		07/			
73h	3473h	[4:0]	X_OUT_SIZE	079Ch		078	9Ch		
80h	3480h	[7:0]	INCKSEL7	92h			//Hz:49h Hz:92h		Set according to INCK

The example of window cropping setting is shown below.

The frame rate is maximum setting as each image format. For adjust the frame rate, please extend the VMAX or the number of lines per frame.

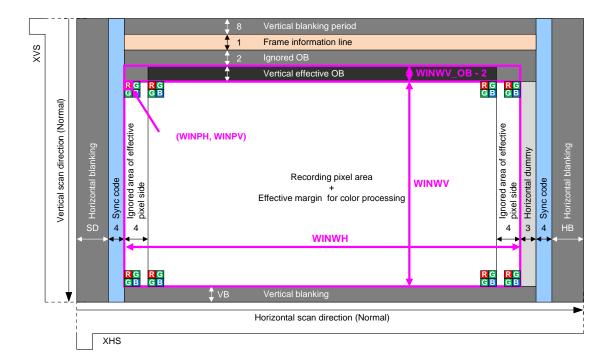
Example of Window cropping Mode Setting

Image	INCK	Output	Frame	Number of recording pixels		Register setting [DEC] (HEX)							
size	[MHz]	Resolution [bit]	rate [frame/s]			FRSEL	HMAX	VMAX	WINPH	WINPV	WINWH	WINWV	
\/CA	37.125	10/12	64.9	040	400	2	4400d (0898h)	520d	640d	300d	656d	496d	
VGA	74.25	10/12	129.8	640	480	1	2200d (898h)	(208h)	(280h)	(12Ch)	(290h)	(1F0h)	
CIE	37.125	10/12	102.9	252	200	2	4400d (0898h)	328d	784d	396d	368d	304d	
CIF	74.25	10/12	205.8	352	288	1	2200d (898h)	(148h)	(310h)	(18Ch)	(170h)	(130h)	

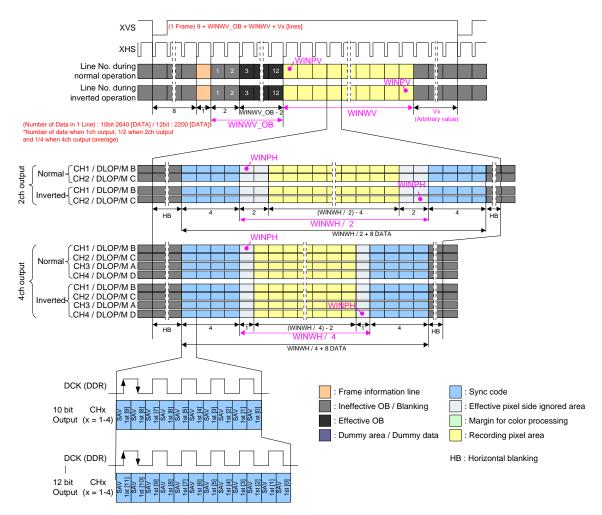
 $^{^{\}star}$ These settings are when the ignored OB line is 2 lines and effective OB line is 10 lines.

^{*} When the CSI-2 output, set the value that is set to register WINWV_OB to register Y_OUT_SIZE.

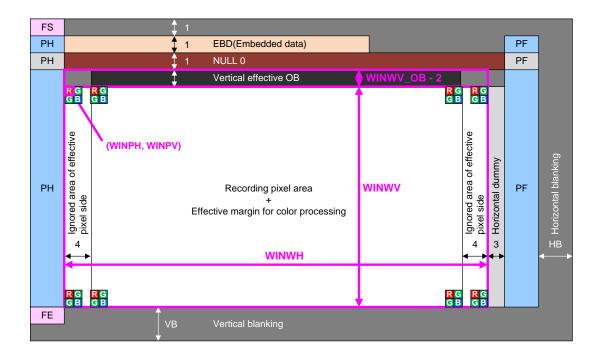




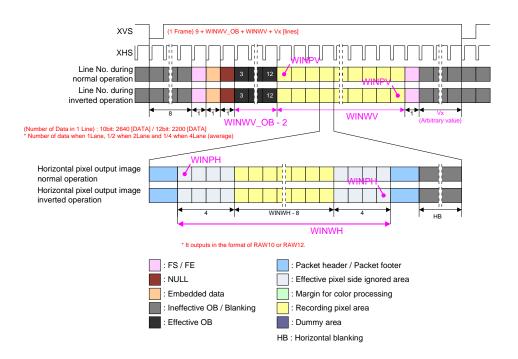
Pixel Array Image Drawing in Window Cropping mode (Serial LVDS output)



Drive Timing Chart for Window Cropping mode (Serial LVDS output)



Pixel Array Image Drawing in Window Cropping mode (CSI-2 serial output)



Drive Timing Chart for Window Cropping mode (CSI-2 serial output)

HD720p mode

List of Setting Register for LVDS serial output

4-wire I ² C Chip ID: 02h	bit	Register Name			Remarks			
Chip ID: 02h		Trogiotor Harrio	Value	2 ch 4 ch				
	p ID: 02h							
05h 3005h	[0]	ADBIT	1h	0h / 1h	0: 10 bit, 1: 12 bit			
	[0]	VREVERSE	0h	0h / 1h	0: Normal, 1: Inverted			
07h 3007h	[1]	HREVERSE	0h	0h / 1h	0: Normal, 1: Inverted			
	[6:4]	WINMODE	0h	1h	HD 720p			
	[1.0]	FRSEL	1h	2h	30 [frame/s]			
09h 3009h	[1.0]	FROLL	1111	1h	60 [frame/s]			
	[4]	FDG_SEL	0h	0h / 1h	0: LCG mode, 1: HCG mode			
12h 3012h		_	F0h	64h	Initial setting			
13h 3013h	[7:0]	_	00h	00h	Initial setting			
18h 3018h								
19h 3019h	[7:0]	VMAX	465h	2EEh	25 /30 / 50 / 60 [frame/s]			
1Ah 301Ah	[1:0]							
1Ch 301Ch	[7:0]			19C8h / 1EF0h	19C8h: 30[frame/s] /			
13.1 00101	[, .0]	HMAX	0898h	100011/121011	1EF0h: 25[frame/s]			
1Dh 301Dh	[7:0]		000011	0CE4h / 0F78h	0CE4h: 60[frame/s] /			
1011 30101				0024117 01 7011	0F78h: 50[frame/s]			
46h 3046h	[1:0]	ODBIT	1h	0h / 1h	0: 10 bit, 1: 12 bit			
4011 304011	[7:4]	OPORTSEL	Eh	Dh Eh	I/F selection			
5Ch 305Ch	[7:0]	INCKSEL1	0Ch	10h / 20h	_			
5Dh 305Dh	[7:0]	INCKSEL2	00h	00h / 00h	Set according to INCK			
5Eh 305Eh	[7:0]	INCKSEL3	10h	10h / 20h	74.25/37.125 MHz			
5Fh 305Fh	[7:0]	INCKSEL4	01h	01h / 01h				
Chip ID = 03h	T	T	1					
29h 3129h	[7:0]	ADBIT1	1Dh	1Dh / 00h	10 bit: 1Dh			
					12 bit: 00h			
	+	INCKSEL5	1Bh	1Bh / 1Ah	INCK: 74.25 / 37.125 MHz			
64h 3164h	[7:0]	INCKSEL6	1Bh	1Bh / 1Ah	INCK: 74.25 / 37.125 MHz			
7Ch 317Ch	[7:0]	ADBIT2	12h	12h / 00h	10 bit: 12h			
					12 bit: 00h			
ECh 31ECh	[7:0]	ADBIT3	37h	37h / 0Eh	10 bit: 37h			
Chin ID 04h					12 bit: 0Eh			
Chip ID = 04h	[7:0]							
00h 3200h	[/:0]		that doa	erihad on itam "Dogistor m	nan"			
FFh 32FFh		Set register value that described on item "Register map".						
Chip ID = 05h	[[/.0]							
00h 3300h	[7:0]							
~ 33001	[7.0]	Set register value	that des	cribed on item "Register m	nap".			
FFh 33FFh		231.09.0101 14140	400	The second of the second of the				
Chip ID = 06h	11							
00h 3400h	[7:01							
~ ~	~	Changing the valu	e is not	necessary.				
7Fh 347Fh	[7:0]		gg and rate is not not observed.					
80h 3480h	[7:0]	INCKSEL7	92h	92h / 49h	INCK: 74.25 / 37.125 MHz			
81h 3481h	[7:0]							
~ ~	~	Changing the valu	e is not	necessary.				
FFh 34FFh	[7:0]							



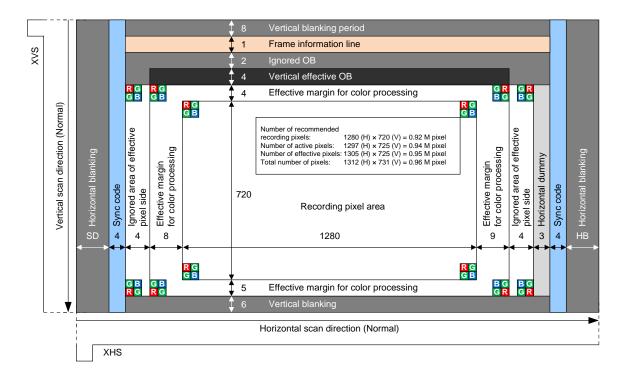
List of Setting Register for CSI-2 serial output

Address			Register	Initial	2 la	CSI-2	ı	ane	_	
4-wire	I ² C	bit	Name	Value	30 [frame /s]	60 [frame /s]	30 [frame /s]	60 [frame /s]	- Remarks	
Chip ID): 02h									
05h	3005h	[0]	ADBIT	1h		0h /	/ 1h		0: 10 bit, 1: 12 bit	
			. (5.5) (5.5.6	-			0: Normal,			
		[0]	VREVERSE	EVERSE 0h 0h / 1h						
07h	3007h	7h [4]	UDE\/EDCE	Oh		Oh	/ 1h		0: Normal,	
		[1]	HREVERSE	0h		Un /	/ 1h		1: Inverted	
		[6:4]	WINMODE	0h		1	h		HD 720p	
		[1:0]	FRSEL	1h	2h	1h	2h	1h		
09h	3009h	[4]	FDG_SEL	0h		0h	/ 1h		0: LCG mode,	
		[4]	FDG_SEL	OH		UIT	/ 111		1: HCG mode	
12h	3012h	[7:0]	_	F0h		64	4h		Initial setting	
13h	3013h	[7:0]	_	00h		00	Oh		Initial setting	
18h	3018h	[7:0]							25 /20 / 50 / 60	
19h	3019h	[7:0]	VMAX	465h	2EEh				25 /30 / 50 / 60 [frame/s]	
1Ah	301Ah	[1:0]						[Irame/s]		
1Ch	301Ch	[7:0]	HMAX	0898h	19C8h /	0CE4h /	19C8h /	0CE4h /	30 / 60[frame / s] /	
1Dh	301Dh	[7:0]	HIVIAA	009011	1EF0h	0F78h	1EF0h	0F78h	25 / 50 [frame / s]	
44h	3044h	[1:0]	ODBIT	1h	1h				In CSI-2, fixed to "1h".	
4411	304411	[7:4]	OPORTSEL	Eh	0h				In CSI-2, fixed to "0h".	
5Ch	305Ch	[7:0]	INCKSEL1	0Ch	10h / 20h					
5Dh	305Dh	[7:0]	INCKSEL2	00h	00h / 00h				Set according to INCK	
5Eh	305Eh	[7:0]	INCKSEL3	10h	10h / 20h				74.25/37.125 MHz	
5Fh	305Fh	[7:0]	INCKSEL4	01h	01h / 01h					
Chip ID = 03h										
29h	3120h	[7·0]	ADBIT1	1Dh		1Dh	/ 00h		10 bit: 1Dh	
2311	312311	[7.0]	ADDITI	IDII		TDII.	12 bit: 00h			
5Eh	315Fh	[7:0]	INCKSEL5	1Bh		1Rh	/ 1Ah		Set according to INCK	
OL!!	OTOLII	[7.0]	II TOROLLO	1011		15117			74.25 / 37.125 MHz	
64h	3164h	[7:0]	INCKSEL6	1Bh		1Bh	/ 1Ah		Set according to INCK	
	0.0	[]					74.25 / 37.125 MHz			
7Ch	317Ch	[7:0]	ADBIT2 12h		12h / 00h				10 bit: 12h	
		[]							12 bit: 00h	
ECh	31ECh	[7:0]	ADBIT3	37h	37h / 0Eh				10 bit: 37h	
		,							12 bit: 0Eh	
Chip ID										
00h	3200h					"5				
~	~	~	Set register value	Set register value that described on item "Register map".						
FFh	32FFh	[[7:0]								
Chip ID		[7.0]								
00h	3300h		Set register value that described on item "Degister man"							
~ FFh	~ 33FFh		Set register value	Set register value that described on item "Register map".						
LLII	SOFFI	[7.0]								

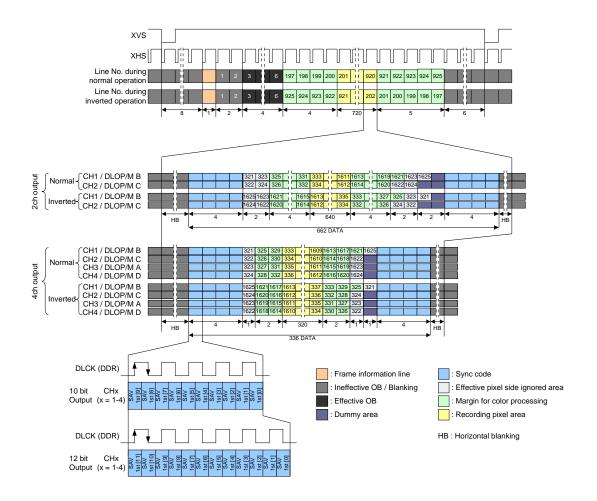


Address					CSI-2				
Add			Register	Initial	2 la	ine	4 la	ane	Remarks
4-wire	I ² C	bit	Name	Value	30	60	30	60	Remarks
4-WITE	10				[frame /s]	[frame /s]	[frame /s]	[frame /s]	
Chip ID	= 06h						T		
	Data rate				297	594	148.5	297	[Mbps / Lane]
05h	3405h	[5:4]	REPETITION	2h	1h	0h	2h	1h	
07h	3407h	[1:0]	PHYSICAL_ LANE_NUM	3h	1h 3h			h	
14h		[5:0]	OPB_SIZE_V	Ah		4	h		
18h	3418h	[7:0]	Y_OUT_SIZE	0449h		20	9h		
19h	3419h	[4:0]	1_001_022	044311			7511		
41h		[7:0]	CSI_DT_FMT	0C0Ch		0A0Ah	/ 0C0Ch		0A0Ah: RAW10
42h	3442h	[7:0]	001_B1_1 W1	000011		0/10/11/			0C0Ch: RAW12
43h	3443h	[1:0]	CSI_LANE_ MODE	3h	1	h	3	h	
44h	3444h	[7:0]				37.125 MF		Set according to INCK	
45h	3445h	[7:0]	EXTCK_FREQ	4A40h		74.25 MH			
46h	3446h	[7:0]	TCLKPOST	047h	04Fh	067h	047h	0.455	Clabal timina
47h	3447h	[0]						04Fh	Global timing
48h	3448h	[7:0]	TUCZEDO	01Fb	00Eh	057h	017h	02Fh	Global timing
49h	3449h	[0]	THSZERO	01Fh	h 02Fh	03711			
4Ah	344Ah	[7:0]	HSPREPARE	≣ 017h 017h	017h	02Eb	00Fh	017h	Global timing
4Bh	344Bh	[0]	THOFKLIARL		017h	02Fh	00111	01711	Global tilling
4Ch	344Ch	[7:0]	CLKTRAIL	00Fh	017h	027h	00Fh	017h	Global timing
4Dh	344Dh	[0]	TOLKTIVAL	00111	01711	02711	00111	01711	Global tilling
4Eh	344Eh	[7:0]	THSTRAIL	017h	017h	02Fh	00Fh	017h	Global timing
4Fh	344Fh	[0]	THOTIVAL	01711	01711	02111	00111	01711	Clobal tilling
50h	3450h	[7:0]	TCLKZERO	047h	057h	0BFh	02Bh	057h	Global timing
51h	3451h	[0]	TOLIVELINO	34711	00711	00111	UZDII	03711	Clobal tilling
52h	3452h	[7:0]	TCLKPREPARE	00Fh	017h	02Fh	00Bh	017h	Global timing
53h	3453h	[0]	. JER REITHE	001 11	01/11	02111	00011	01711	C.S.Z. Milling
54h	3454h	[7:0]	TLPX	00Fh	017h	027h	00Fh	017h	Global timing
55h	3455h	[0]	. =. ^	30	V 11111	V2711	00111	01711	C.C.C. Milling
72h	3472h	[7:0]	X_OUT_SIZE	079Ch		E1			
73h	3473h	[4:0]	N_001_31ZE	013011	51Ch				
80h	3480h	[7:0]	INCKSEL7	92h	37.125 MHz : 49h 74.25 MHz : 92h				Set according to INCK

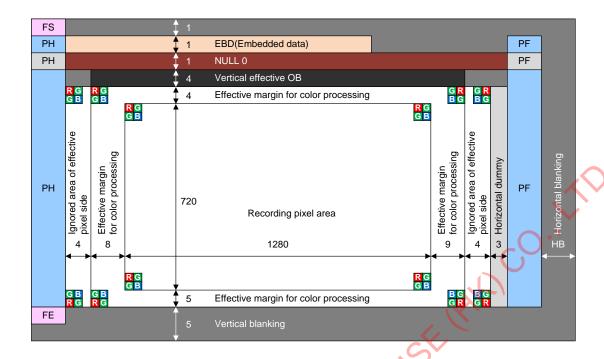




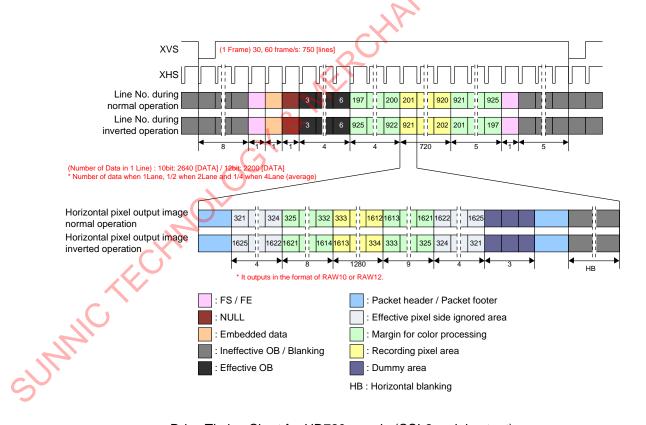
Pixel Array Image Drawing in HD720p mode (Serial LVDS output)



Drive Timing Chart for HD720p mode (Serial LVDS output)



Pixel Array Image Drawing in HD720p mode (CSI-2 serial output)



Drive Timing Chart for HD720p mode (CSI-2 serial output)

Description of Various Function

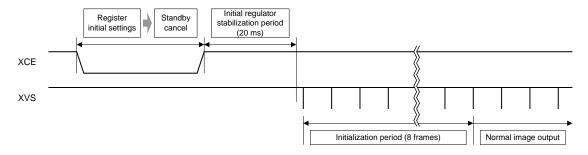
Standby Mode

This sensor stops its operation and goes into standby mode which reduces the power consumption by writing "1" to the standby control register STANDBY. Standby mode is also established after power-on or other system reset operation.

List of Standby Mode Setting

Register name		Register	details		Initial value	Setting value	Status	Remarks
	Register	Chip ID	Address (): I ² C	bit				
STANDBY	_	1 02h 1	00h (3000h) [0]	[0]	1	1		Register communication is executed in standby mode.
				[O]	-	0		

The serial communication registers hold the previous values. However, the address registers transmitted in standby mode are overwritten. The serial communication block operates even in standby mode, so standby mode can be canceled by setting the STANDBY register to "0". Some time is required for sensor internal circuit stabilization after standby mode is canceled. After standby mode is canceled, a normal image is output from the 9 frames after internal regulator stabilization (20 ms or more).



Sequence from Standby Cancel to Stable Image Output

Slave Mode and Master Mode

The sensor can be switched between slave mode and master mode. The switching is made by the XMASTER pin. Establish the XMASTER pin status before canceling the system reset. (Do not switch this pin status during operation.)

Input a vertical sync signal to XVS and input a horizontal sync signal to XHS when a sensor is in slave mode. For sync signal interval, input data lines to output for vertical sync signal and 1H period designated in each operating mode for horizontal sync signal. See the section of "Operating mode" for the number of output data line and 1H period.

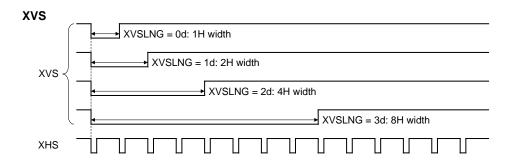
Set the XMSTA register to "0" in order to start the operation after setting to master mode. In addition, set the count number of sync signal in vertical direction by the VMAX [17:0] register and the clock number in horizontal direction by the HMAX [13:0] register. See the description of Operation Mode for details of the section of "Operating Modes".

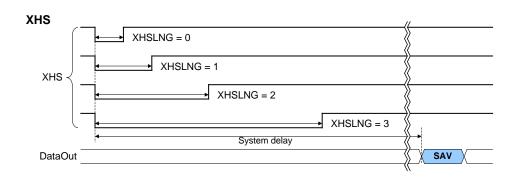
List of Slave and Master Mode Setting

Pin name	Pin processing	Operating mode	Remarks	
VMACTED nin	Fixed to Low	Master mode	High: OV _{DD}	
XMASTER pin	Fixed to High	Slave mode	Low: GND	

List of Register in Master Mode

	Register detail	s (Chip ID	= 02h)	Initial		
Register name	er name Register Address bit value Setting value		Remarks			
XMSTA		02h (3002h)	[0]	1	Master operation ready Master operation start	The master operation starts by setting 0.
	VMAX [7:0]	18h (3018h)	[7:0]			Line number per frame designated
VMAX [17:0]	VMAX [15:8]	19h (3019h)	[7:0]	00465h	See the item of each drive mode.	
	VMAX [17:16]	1Ah (301Ah)	[1:0]			
LIMAN (140.01	HMAX [7:0]	1Ch (301Ch)	[7:0]	0898h	See the item of each drive mode.	Clock number per line designated
HMAX [13:0]	HMAX [15:8]	1Dh (301Dh)	[7:0]	009011		
XVSLNG [1:0]	_	48h (3048h)	[5:4]	0h	0: 1H, 1: 2H, 2: 4H, 3: 8H	XVS low level pulse width designated
XHSLNG [1:0]		49h (3049h)	[5:4]	0h	0: Min. to 3: Max. See the next	XHS low level pulse width designated
XVSOUTSEL [1:0]	SEL [1:0] — 4Bh		[1:0]	0h	Fixed to High VSYNC output Others: Setting prohibited	
XHSOUTSEL [1:0]	_	(304Bh)	[3:2]	0h	0: Fixed to High 2: HSYNC output Others: Setting prohibited	





XVS/XHS output waveform in sensor master mode

List of XHSLNG Register

	LVDS serial output							
DCK	594	297	148.5	445.5	222.75	111.375		
DCK	[Mbps / ch]	[Mbps / ch]	[Mbps / ch]	[Mbps / ch]	[Mbps / ch]	[Mbps / ch]		
XHSLNG = 0	64 bit	32 bit	16 bit	48 bit	24 bit	12 bit		
XHSLNG = 1	128 bit	64 bit	32 bit	96 bit	48 bit	24 bit		
XHSLNG = 2	256 bit	128 bit	64 bit	192 bit	96 bit	48 bit		
XHSLNG = 3	512 bit	256 bit	128 bit	384 bit	192 bit	96 bit		

The XVS and XHS are output in timing that set 0 to the register XMSTA. If set 0 to XMSTA during standby, the XVS and XHS are output just after standby is released. The XVS and XHS are output asynchronous with other input or output signals. In addition, the output signals are output with a undefined latency time (system delay) relative to the XHS. Therefore, refer to the sync codes output from the sensor and perform synchronization.

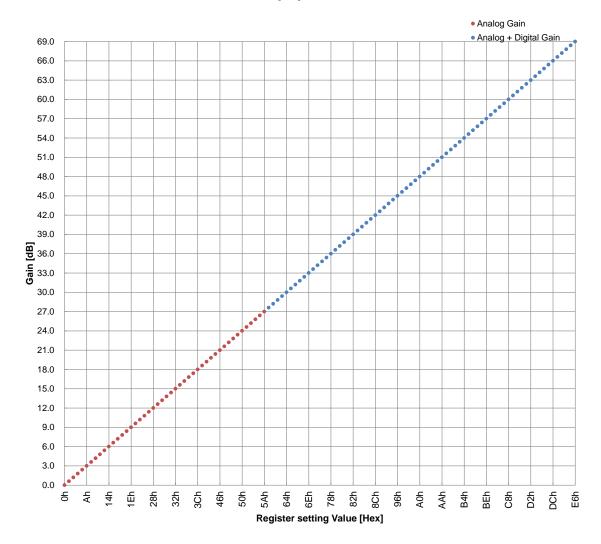
Gain Adjustment Function

The Programmable Gain Control (PGC) of this device consists of the analog block and digital block. The total of analog gain and digital gain can be set up to 69 dB by the GAIN [7:0] register setting. The same setting is applied in all colors.

The value which is 10/3 times the gain is set to register. (0.3 dB step)

Example)

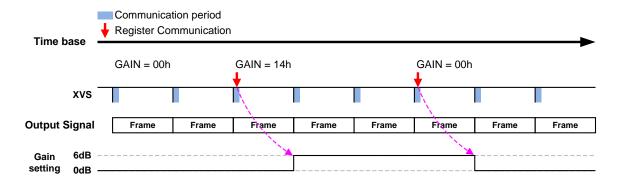
When set to 6 dB: $6 \times 10/3 = 20d$; GAIN [7:0] = 14h When set to 12.6 dB: $12.6 \times 10/3 = 42d$; GAIN [7:0] = 2Ah



List of PGC Register

Register	Register deta	ils (Chip ID =	02h)	Initial	Setting value	Remarks	
name	Register	Address (): I ² C	bit	value	Setting range	Remarks	
GAIN [7:0]	GAIN [7:0]	14h (3014h)	[7:0]	00h	00h-E6h (0d-230d)	Setting value: Gain [dB] x 10/3 (0.3 dB step)	

The gain setting is reflected at the next frame that the communication is performed as shown below.



Gain Reflection Timing

Black Level Adjustment Function

The black level offset (offset variable range: 000h to 1FFh) can be added relative to the data in which the digital gain modulation was performed by the BLKLEVEL [8:0] register. When the BLKLEVEL setting is increased by 1 LSB, the black level is increased by 1 LSB.

Use with values shown below is recommended.

10-bit output: 03Ch (60d) 12-bit output: 0F0h (240d)

List of Black Level Adjustment Register

	Register detai	Is (Chip ID = 02h)	Initial			
Register name	Register Address (): I ² C		bit	value	Setting value	
DIVIEVEL [6:0]	BLKLEVEL [7:0]	0Ah (300Ah)	[7:0]	0F0h	000h to 1FFh	
BLKLEVEL [8:0]	BLKLEVEL [8]	0Bh (300Bh)	[0]	OFON		

Normal Operation and Inverted Operation

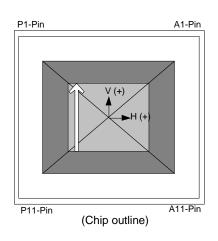
The sensor readout direction (normal / inverted) in vertical direction can be switched by the VREVERSE register setting and in horizontal direction can be switched by the HREVERSE register setting. See the section of "Operating Modes" for the order of readout lines in normal and inverted modes. One invalid frame is generated when reading immediately after the readout direction change in order to switch the normal operation and inversion between frames.

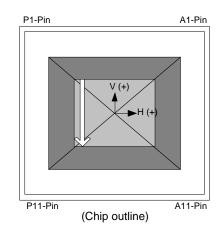
List of Drive Direction Setting Register

	Register detai	ls (Chip ID = 02h)	Initial		
Register name	Register	Address ():I ² C	bit	value	Setting value
VREVERSE	_	07h	[0]	0h	0: Normal (Initial value) 1: Vertical Inverted
HREVERSE	_	(3007h)	[1]	0h	0: Normal (Initial value) 1: Horizontal Inverted

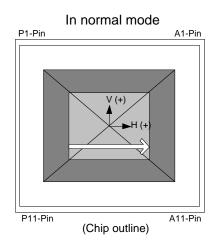
In normal mode

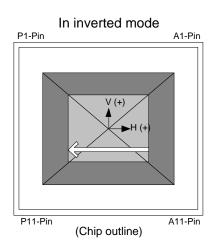
In inverted mode





Normal and Inverted Drive Outline in Vertical Direction (TOP VIEW)





Normal and Inverted Drive Outline in Horizontal Direction (TOP VIEW)

Shutter and Integration Time Settings

This sensor has a variable electronic shutter function that can control the integration time in line units. In addition, this sensor performs rolling shutter operation in which electronic shutter and readout operation are performed sequentially for each line.

Note) For integration time control, an image which reflects the setting is output from the frame after the setting changes.

Example of Integration Time Setting

The sensor's integration time is obtained by the following formula.

Integration time = 1 frame period - $(SHS1 + 1) \times (1H period)$

- *1 The frame period is determined by the input XVS when the sensor is operating in slave mode, or the register VMAX value in master mode. The frame period is designated in 1H units, so the time is determined by (Number of lines × 1H period).
- *2 See "Operating Modes" for the 1H period.

In this section, the shutter operation and storage time are shown as in the figure below with the time sequence on the horizontal axis and the vertical address on the vertical axis. For simplification, shutter and readout operation are noted in line units.

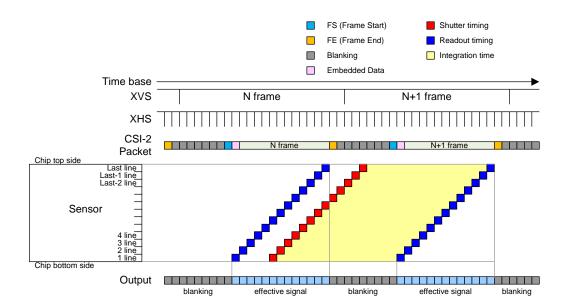


Image Drawing of Shutter Operation

Normal Exposure Operation (Controlling the Integration Time in 1H Units)

The integration time can be controlled by varying the electronic shutter timing. In the electronic shutter settings, the integration time is controlled by the SHS1 [17:0] register. Set SHS1 [17:0] to a value between 1 and (Number of lines per frame - 1). When the sensor is operating in slave mode, the number of lines per frame is determined by the XVS interval (number of lines), using the input XHS interval as the line unit.

When the sensor is operating in master mode, the number of lines per frame is determined by the VMAX register. The number of lines per frame differs according to the operating mode.

Registers Used to Set the Integration Time in 1H Units

	Register detai	ls (Chip ID = 0)2h)		
Register name	Register	Address (): I ² C	bit	Initial value	Setting value
	SHS1 [7:0]	20h (3020h)	[7:0]		Sets the shutter sweep time.
SHS1 [17:0]	SHS1 [15:8]	21h (3021h)	[7:0]	00000h	1 to (Number of lines per frame - 2) * 0 and number of lines per frame -1
	SHS1 [17:16]	22h (3022h)	[1:0]		setting is prohibited
	VMAX [7:0]	18h (3018h)	[7:0]		
VMAX [17:0]	VMAX [15:8]	19h (3019h)	[7:0]	00465h	Sets the number of lines per frame (only in master mode). See "Operating Modes" for the setting value in each mode.
	VMAX [17:16]	1Ah (301Ah)	[1:0]		The same seeming value in each mount

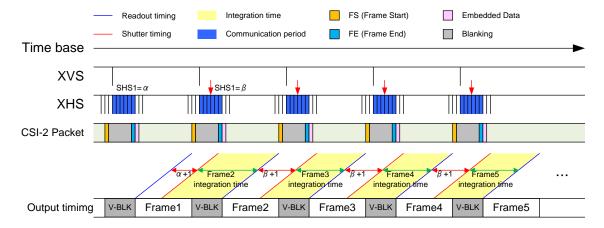


Image Drawing of Integration Time Control within a Frame

Long Exposure Operation (Control by Expanding the Number of Lines per Frame)

Long exposure operation can be performed by lengthening the frame period.

When the sensor is operating in slave mode, this is done by lengthening the input vertical sync signal (XVS) pulse interval.

When the sensor is operating in master mode, it is done by designating a larger register VMAX [17:0] value compared to normal operation. When the integration time is extended by increasing the number of lines, the rear V blanking increases by an equivalent amount.

Although the maximum value of long exposure operation changes in each modes, the maximum of long time exposure is approximately 1 s.

When set to a number of V lines or more than that noted for each operating mode, the imaging characteristics are not quaranteed during long exposure operation.

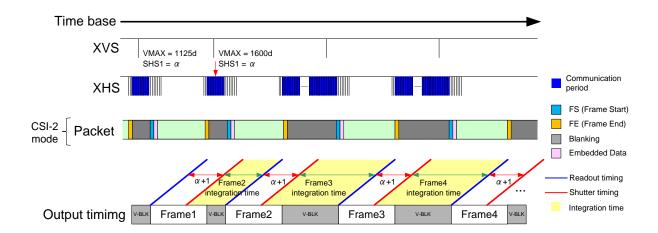


Image Drawing of Long Integration Time Control by Adjusting the Frame Period

Example of Integration Time Settings

The example of register setting for controlling the storage time is shown below.

Example of Integration Time Settings (In Full HD 1080p)

0	Sensor setti	ng (register)	Internation time	
Operation	VMAX [*]	SHS1**	Integration time	
		1123	1H	
	1125	:	:	
Normal frame rate		N	(1125 - (N + 1)) H	
		:	:	
		1	1123H	

^{*} In sensor master mode. In slave mode, the interval is the same as XVS input.

^{**} The SHS1 setting value (N) is set between "1" and "the VMAX value (M) -2".

Signal Output

Output Pin Settings

The output formats of this sensor support the following modes.

Low voltage LVDS serial (2 ch / 4 ch switching) DDR output CSI-2 serial (2 Lane / 4 Lane, RAW10 / RAW12) output

The switching for serial interface is made by the OMODE pin. Establish the OMODE pin status before canceling the system reset. (Do not switch this pin status during operation.) Each mode is set using the register OPORTSEL. The table below shows the output format settings.

List of Interface Switching

Pin name	Pin	Interface	Remarks
OMODE pin	Fixed to Low	CSI-2 serial	High: OVDD
ONIODE PIN	Fixed to High	Low voltage LVDS serial	Low: GND

List of Output Interface Setting Register

Degister name	Register d (Chip ID =				Description	
Register name	Address ():I ² C	bit	value	value	Description	
				Dh	Low voltage LVDS serial 2 ch DDR	
OPORTSEL	46h	[7,4]		Eh	Low voltage LVDS serial 4 ch DDR	
[3:0] (3046h) ^{[1}	[7:4]	Eh	N/A	CSI-2 serial 2Lane		
				N/A	CSI-2 serial 4Lane	

^{*} In CSI-2 output, set registers that described in section "CSI-2 output setting".

Each output pin is shown in the table below when setting low-voltage LVDS serial 2 ch / 4 ch output.

Output Pins for Low LVDS Serial and CMOS parallel

	Low voltage LVDS serial DDR output					
DOP/DOM	2 ch	4 ch				
DLOMD	Hi-Z	Ch4 / M				
DLOPD	Hi-Z	Ch4/P				
DLOMC	Ch2/M	Ch2 / M				
DLOPC	Ch2 / P	Ch2/P				
DLOMB	Ch1 / M	Ch1 / M				
DLOPB	Ch1 / P	Ch1 / P				
DLOMA	Hi-Z	Ch3 / M				
DLOPA	Hi-Z	Ch3 / P				

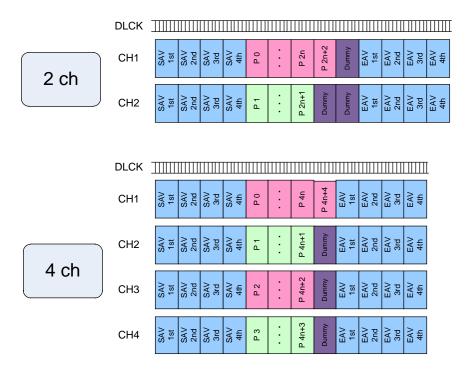
Low-voltage LVDS serial 2 ch / 4 ch output format is shown in the figure below.

When setting 2 ch, after four data of SAV is output in the order of CH1 and CH2 pixel data is repeatedly output in the same order and then four data of EAV is output in the same order to CH1 and CH2 respectively.

When setting 4 ch, after four data of SAV is output in the order of CH1, CH2, CH3 and CH4 pixel data is repeatedly output in the same order and then four data of EAV is output in the same order to CH1, CH2, CH3 and CH4 respectively.

Data is sent MSB first.

For details, see drive timing in each mode in the section of "Operation Mode".



Output Format of Low voltage LVDS Serial 2 ch / 4 ch (Full HD 1080p)

CSI-2 output

The output formats of this sensor support the following modes.

CSI-2 serial 2 Lane / 4 Lane, RAW10 / RAW12

The 2 Lane / 4 Lane serial signal output method using this sensor is described below.

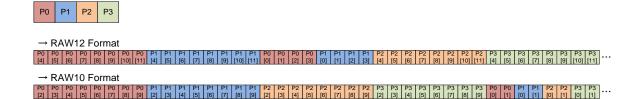
Complied with the CSI-2, data is output using 2 Lane / 4 Lane. The image data is output from the CSI-2 output pin. The DMO1P/DMO1N are called the Lane1 data signal, the DMO2P/DMO2N are called the Lane2 data signal, the DMO3P/DMO3N are called the Lane3 data signal, the DMO4P/DMO4N are called the Lane4 data signal. In addition, the clock signals are output from DMCKP/DMCKN of the CSI-2 pins.

In 2 Lane mode, data is output from Lane1 and Lane2. In 4 Lane mode, data is output from Lane1, Lane3, Lane3 and Lane4. The bit rate maximum value is 891 Mbps / Lane.

The select of RAW10 / RAW12 is set by the register: CSI_DT_FMT [15:0] The number of output lanes is set by the register: CSI_LANE_MODE [1:0] and the number of lanes physically connected is set by PHYSICAL_LANE_NUM [1:0]. Unused lanes (when setting 2 lanes; DMO3P / DMO3N, DMO4P / DMO4N) are set to Hi-Z output by the setting. When the number of lanes more than CSI_LANE_MODE is set by PHYSICAL_LANE_NUM, unused lanes output signals conformed to MIPI standard.

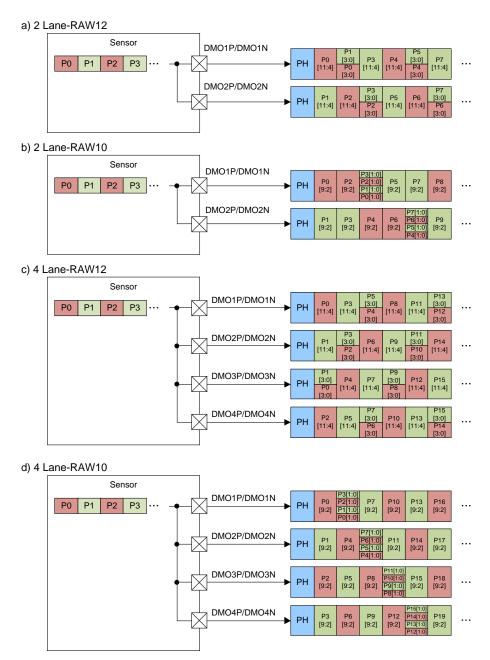
5	Register details (Chip ID = 06h)		Initial	Setting	Description	
Register name	Address (): I ² C	bit	value	value	Description	
OOL DT. EMT.ME.OL	41h (7:0) (3441h) (7:0) 0C0Ch		0A0Ah	RAW10		
CSI_DT_FMT [15:0]	42h (3442h)	[7:0]	000011	0C0Ch	RAW12	
	07h (3407h)	[1:0]		0h	Setting prohibited	
PHYSICAL_LANE_NUM			3h	1h	2Lane	
[1:0]				2h	Setting prohibited	
				3h	4Lane	
				0h	Setting prohibited	
CSI_LANE_MODE [1:0]	43h	[4.0]	٥h	1h	2Lane	
	(3443h)	[1:0]	3h	2h	Setting prohibited	
				3h	4Lane	

The formats of RAW12 and RAW10 are shown below.



The Example of Format of RAW12 / RAW10

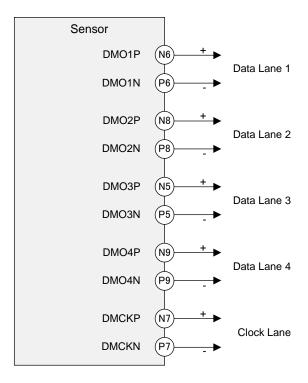
The each formal of 2 Lane and 4 Lane are shown below.



2 Lane / 4 Lane Output Format

MIPI Transmitter

Output pins (DMO1P, DMO1N, DMO2P, DMO2N, DMO3P, DMO3N, DMO4P, DMO4N, DMCKP, DMCKN) are described in this section.

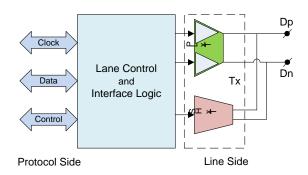


Relationship between Pin Name and MIPI Output Lane

The pixel signals are output by the CSI-2 High-speed serial interface. See the MIPI Standard

- MIPI Alliance Standard for Camera Serial Interface 2 (CSI-2) Version 1.01.00
- MIPI Alliance Specification for D-PHY Version 1.00.00

The CSI-2 transfers one bit with a pair of differential signals. The transmitter outputs differential current signal after converting pixel signals to it. Insert external resistance in differential pair in a series or use cells with a built-in resistance on the Receiver side. When inserting an external resistor, as close as possible to the Receiver. The differential signals maintain a constant interval and reach the receiver with the shortest wiring length possible to avoid malfunction. The maximum bit rate of each Lane are 891 Mbps / Lane.



Universal Lane Module Functions

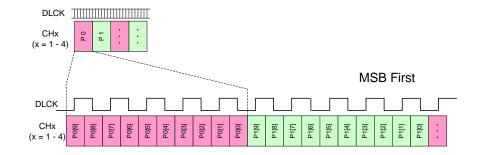
Output Pin Bit Width Selection

The output pin width can be selected from 10-bit or 12-bit output using the register ODBIT. When low-voltage LVDS serial output, continuous data is output MSB first by 10-bit and 12-bit output setting respectively. 10-bits sync code are output when ODBIT = 0 (10-bit output), and 12-bit sync codes are output when ODBIT = 1 (12-bit output).

Output Pin Bit Width Selection Setting Register

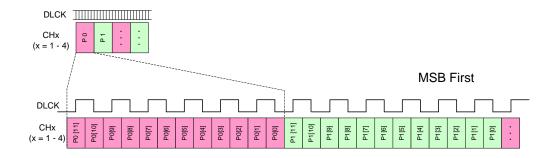
Register	Register de	Initial				
name	Register Address (): I ² C		bit	value	Setting value	
ODBIT	_	46h (3046h)	[0]	1h	0: 10 bit 1: 12 bit	

ODBIT = 0 (Low voltage LVDS serial 10 bit output)



Example of Data format in low-voltage LVDS serial 10-bit output

ODBIT = 1 (Low voltage LVDS serial 12 bit output)



Example of Data format in low-voltage LVDS serial 12-bit output

Number of Internal A/D Conversion Bits Setting

The number of internal A/D conversion bits can be selected from 10 bits or 12 bits by the register ADBIT. See the section of "Operating Modes" for the correspondence with each mode.

List of Bit Width Selection

Register	*1: C	ster details hip ID = 02h hip ID = 03h		Initial value	Setting value	
name	Register	Address (): I ² C	bit			
ADBIT	_	05h *1 (3005h)	[0]	1h	0: 10 bit 1: 12 bit	
ADBIT1[7:0]	_	29h *2 (3129h)	[7:0]	1Dh	10 bit: 1Dh 12 bit: 00h	
ADBIT2[7:0]	_	7Ch *2 (317Ch)	[7:0]	12h	10 bit: 12h 12 bit: 00h	
ADBIT3[7:0]	_	ECh *2 (31ECh)	[7:0]	37h	10 bit: 37h 12 bit: 0Eh	

Output Rate Setting

The sensor output rate is determined uniformly by the sensor operating mode and the output format. See the section of "Operating Modes" for the relationship between each setting and the frame rate, data rate and data bit rate. The registers related to mode setting are shown in the table below.

Related Registers for Setting Operation Mode

	Register de	etails (Chip ID	e 02h)	Initial	
Register name	Register	Address ():I ² C	bit	value	Setting value
WINMODE [2:0]	_	07h (3007h)	[6:4]	0h	0: Full HD 1080p 1: 720 p 4: Window cropping from Full HD 1080p
FRSEL [1:0]	_	09h (3009h)	[1:0]	1h	1: 60 frame / s 2: 30 frame / s 0,3: Setting prohibited

Output Signal Range

In sub LVDS output mode, the sensor output has 10 bit or 12 bit gray scale according to the setting. The output is not performed at full range and the range is the values shown in the table below See the item of "Sync Codes" in the section of "Operating Modes" for the sync codes.

Output Gradation and Output Range (Low voltage LVDS Output)

0	Output value			
Output gradation	Min.	Max.		
10 bit	001h	3FEh		
12 bit	001h	FFEh		

In CSI-2 output mode, the sensor output has either a 10 bit or 12 bit gradation, but output is not performed over the full range, and the maximum output value is the 3FFh value (10 bit output) and the FFFh one (12 bit output). The output range for each output gradation is shown in the table below.

Output Gradation and Output Range (CSI-2 Output)

0	Output value			
Output gradation	Min.	Max.		
10 bit	000h	3FFh		
12 bit	000h	FFFh		

INCK Setting

The available operation mode varies according to INCK frequency. Input either 37.125 MHz or 74.25 MHz for INCK frequency. The INCK setting register and the list of INCK setting are shown in the table below.

INCK Setting Register

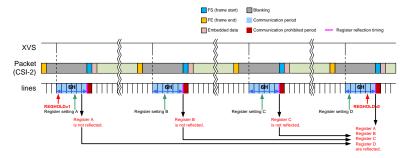
Register name	Register details *1: Chip ID = 02h *2: Chip ID = 03h *3: Chip ID = 06h		Initial value	INCK	= 37.125	5 MHz	INCK	(= 74.25	MHz	
	Register	Address (): I ² C	bit		1080p LVDS	1080p CSI-2	720p	1080p LVDS	1080p CSI-2	720p
INCKSEL1		5Ch *1 (305Ch)	[7:0]	0Ch	18h	18h	20h	0Ch	0Ch	10h
INCKSEL2	_	5Dh *1 (305Dh)	[7:0]	00h	00h	03h	00h	00h	03h	00h
INCKSEL3	_	5Eh *1 (305Eh)	[7:0]	10h	20h	20h	20h	10h	10h	10h
INCKSEL4	_	5Fh *1 (305Fh)	[7:0]	01h	01h	01h	01h	01h	01h	01h
INCKSEL5	_	5Eh *2 (315Eh)	[7:0]	1Bh	1Ah	1Ah	1Ah	1Bh	1Bh	1Bh
INCKSEL6	_	64h *2 (3164h)	[7:0]	1Bh	1Ah	1Ah	1Ah	1Bh	1Bh	1Bh
INCKSEL7	_	80h *3 (3480h)	[7:0]	92h	49h	49h	49h	92h	92h	92h

Register Hold Setting

Register setting can be transmitted with divided to several frames and it can be reflected globally at a certain frame by the register REGHOLD. Setting REGHOLD = 1 at the start of register communication period prevents the registers that are set thereafter from reflecting at the frame reflection timing. The registers that are set when setting REGHOLD = 1 are reflected globally by setting REGHOLD = 0 at the end of communication period of the desired frame to reflect the register.

Register Hold Setting Register

Pogiator	Register det	ails (Chip ID = 0	2h)	Initial	
Register name	Register	Address ():I ² C	bit	value	Setting value
REGHOLD	_	01h (3001h)	[0]	0h	0: Invalid 1: Valid (Register hold)



Register Hold Setting



Software Reset (CMOS parallel / Low voltage LVDS serial only)

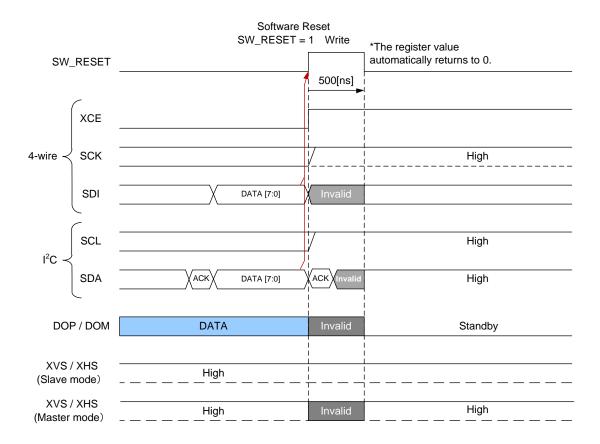
This function is prohibited in CSI-2 output mode.

Software reset can be performed by register setting using the register SW_RESET.Sensor reset is performed by setting SW_RESET = 1. However, the communication to continuous address cannot use. The registers become initial state and standby 500 ns after setting SW_RESET = 1. The SW_RESET signal returns to "0" automatically. The DLOPA-D/DLOMA-H/DCKP/DCKM terminal will be Hi-Z.

The XVS and XHS output High in master mode. Input High to the XVS and XHS before setting SW_RESET = 1 in slave mode. Follow the sequence in the item of "Standby Mode" to perform register initial setting and standby cancel from standby state.

Software Reset Register Setting

Register details (Chip ID = 02h)						
Register name	Register	Address (): I ² C	bit	Initial value	Setting value	
SW_RESET	<u> </u>	03h (3003h)	[0]	0h	0: Normal Operation 1: Reset	



Software Reset

SONY

IMX307LQR-C

Mode Transitions

When changing the operating mode during sensor drive operation, set via sensor standby. However, these transitions that described below can be transitions without standby.

- ◆ Change the number of vertical lines (In sensor master mode, change the VMAX. In sensor slave mode, change the period of XVS input.)
- ◆ Horizontal and vertical scan direction. (When the vertical scan direction is changed, an invalid frame generates during transition.)
- ◆ Change the HCG mode and LCG mode.
- ◆ Change the mode between All-pixel scan and Window cropping. (However, It is case that transitions by not changing register HMAX and FRSEL. In addition, an invalid frame generates during transition.)

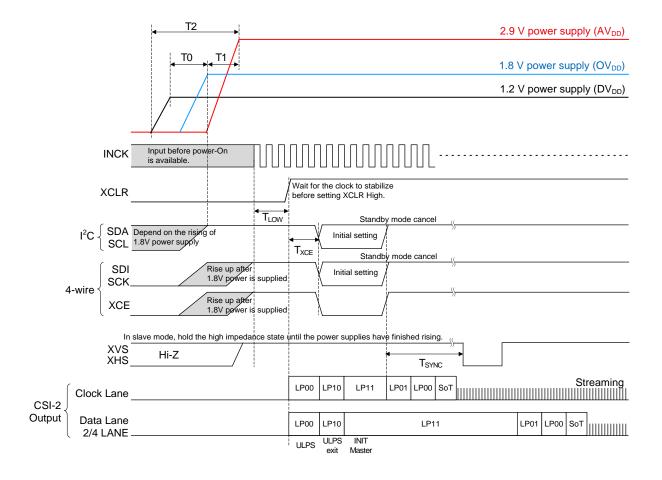
When changing input INCK frequency (register INCKSEL1, INCKSEL2, INCKSEL3, INCKSEL4, INCKSEL5, INCKSEL6, and INCKSEL7 change) or when operating mode transition that changes output bit width (register ODBIT) or output format (register OPORTSEL [3:0]), always start the operation via sensor standby after changing mode during standby following the standby cancel sequence.

When changing input INCK frequency, care should be taken not to be input pulses whose width are shorter than the High / Low level width in front and behind of the INCK pulse at the frequency change. If the pulses above generate at the frequency change, change INCK frequency during system reset in the state of XCLR = Low, and then perform system clear in the state of XCLR = High following the item of "Power on sequence" in the section of "Power on / off sequence". Execute initial setting again because the register settings become default state after system clear.

Power-on and Power-off Sequence

Power-on sequence

- 1. Turn On the power supplies so that the power supplies rise in order of 1.2 V power supply (DV_{DD}) \rightarrow 1.8 V power supply (OV_{DD}) \rightarrow 2.9 V power supply (AV_{DD}). In addition, all power supplies should finish rising within 200 ms.
- 2. Start master clock (INCK) input after turning On the power supplies.
- 3. The register values are undefined immediately after power-on, so the system must be cleared. Hold XCLR at Low level for 500 ns or more after all the power supplies have finished rising. (The register values after a system clear are the default values.) In addition, hold XCE to High level during this period. Rise XCE after 1.8 V power supply (OVDD).
- 4. The system clear is applied by setting XCLR to High level. However, the maser clock needs to stabilize before setting the XCLR pin to High level.
- Make the sensor setting by register communication after the system clear. A period of 20 μs or more should be provided after setting XCLR High before inputting the communication enable signal XCE. In I²C communication, XCE is fixed to High.

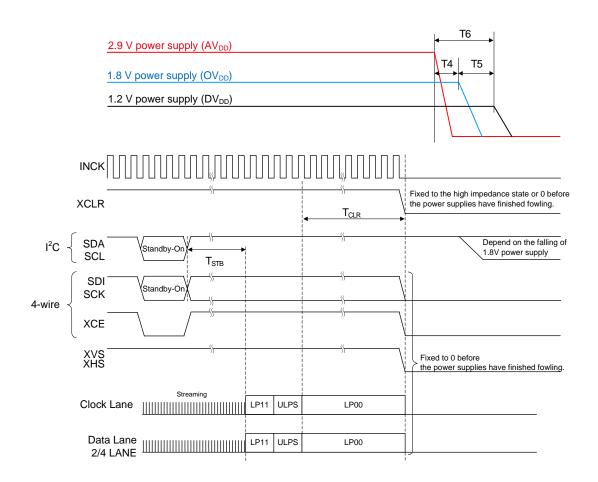


Power-on Sequence

Item	Symbol	Min.	Max.	Unit
1.2 V power supply rising → 1.8 V power supply rising	T0	0	_	ns
1.8 V power supply rising → 2.9 V power supply rising	T1	0	_	ns
Rising time of all power supply	T2	_	200	ms
INCK active → Clear OFF	T _{LOW}	500	_	ns
Clear OFF → Communication start	T _{XCE}	20	_	μs
Standby OFF (communication)	_	20		
→ External input XHS,XVS (slave mode only)	T _{SYNC}	20		ms

Power-off sequence

Turn Off the power supplies so that the power supplies fall in order of 2.9 V power supply $(AVDD) \rightarrow 1.8 \text{ V}$ power supply $(DVDD) \rightarrow 1.2 \text{ V}$ power supply (DVDD). In addition, all power supplies should falling within 200 ms. Set each digital input pin (INCK, XCE, SCK, SDI, XCLR, XMASTER, OMODE, XVS, XHS) to 0 V before the 1.8 V power supply (OVDD) falls.



Power-off Sequence

Item	Symbol	Min.	Max.	Unit
Standby ON (communication) → LP11 mode start	T _{STB}	Until FE		
LP00 → XCLR falling	T _{CLR}	128	_	cycle
2.9 V power shut down → 1.8 V power shut down	T4	0		ns
1.8 V power shut down → 1.2 V power shut down	T5	0		ns
Shut down time of all power supply	T6	_	200	ms

Sensor Setting Flow

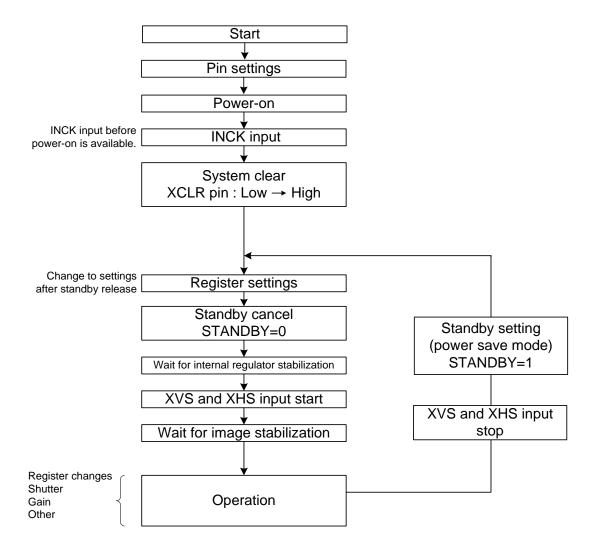
Setting Flow in Sensor Slave Mode

The figure below shows operating flow in sensor slave mode.

For details of "Power-on" to "Reset cancel", see the item of "Power-on sequence" in this section.

For details of "Standby cancel" until "Wait for image stabilization", see the item of "Standby mode".

"Standby setting (power save mode) can be made by setting the STANDBY register to "1" during "Operation".



Sensor Setting Flow (Sensor Slave Mode)

Setting Flow in Sensor Master Mode

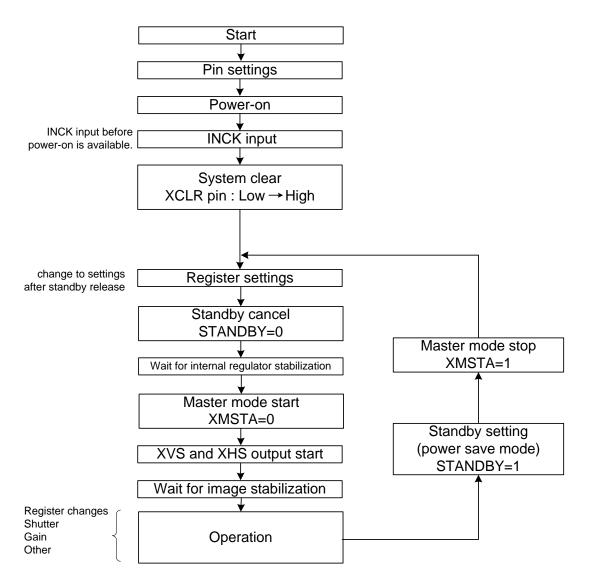
The figure below shows operating flow in sensor master mode.

For details of "Power-on" to "Reset cancel", see the item of "Power on sequence" in this section.

For details of "Standby cancel" until "Wait for image stabilization", see the item of "Standby mode".

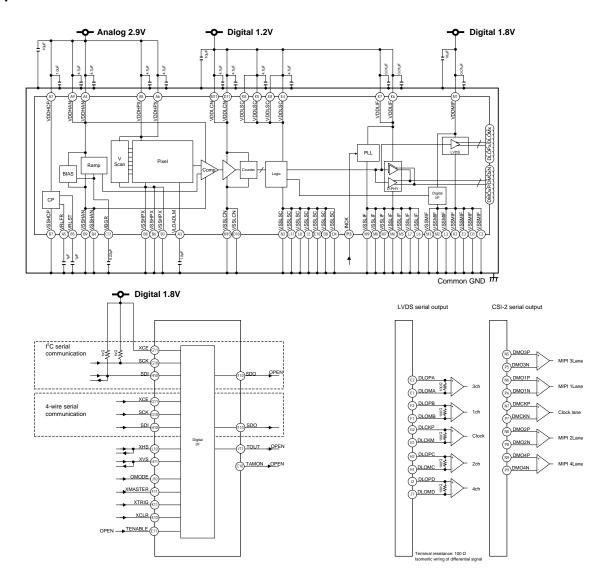
In master mode, "Master mode start" by setting register XMSTA to "0" after "Waiting for internal regulator stabilization"

"Standby setting (power save mode) can be made by setting the STANDBY register to "1" during "Operation". This time, set "master mode stop" by setting XMSTA to "1".



Sensor Setting Flow (Sensor Master Mode)

Peripheral Circuit



Application circuits shown are typical examples illustrating the operation of the devices. Sony cannot assume responsibility for any problems arising out of the use of these circuits or for any infringement of third party and other right due to same.

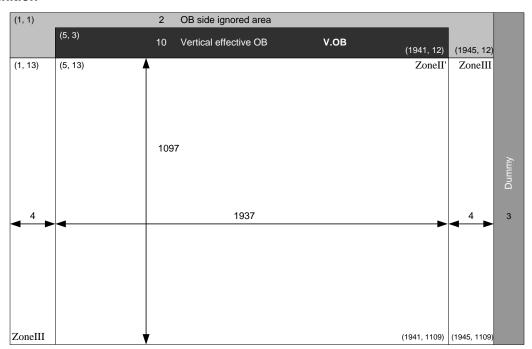
Spot Pixel Specifications

 $(AV_{DD} = 2.9 \text{ V}, OV_{DD} = 1.8 \text{ V}, DV_{DD} = 1.2 \text{ V}, Tj = 60 ^{\circ}C, 30 \text{ frame/s}, Gain: 0 dB, LCG mode)$

		Maximum distorted pixels in each zone				Measurement	
Type of distortion	Level	0 to II'	Effective OB	III	Ineffective OB	method	Remarks
Black or white	30 % < D	15	No evaluation criteria applied		4		
pixels at high light	30 % <u><</u> D	15			ed	I	
White pixels	5.6 m)/ . D	0.57/ D		No evaluation		2	1/20 o otorogo
in the dark	5.6 mV <u><</u> D	40	400		criteria applied		1/30 s storage

- Note) 1. Zone is specified based on all-pixel drive mode
 - 2. D Spot pixel level
 - 3. See the Spot Pixel Pattern Specifications for the specifications in which pixel and black pixel are close.

Zone Definition



Notice on White Pixels Specifications

After delivery inspection of CMOS image sensors, cosmic radiation may distort pixels of CMOS image sensors, and then distorted pixels may cause white point effects in dark signals in picture images. (Such white point effects shall be hereinafter referred to as "White Pixels".) Unfortunately, it is not possible with current scientific technology for CMOS image sensors to prevent such White Pixels. It is recommended that when you use CMOS image sensors, you should consider taking measures against such White Pixels, such as adoption of automatic compensation systems for White Pixels in dark signals and establishment of quality assurance standards. Unless the Seller's liability for White Pixels is otherwise set forth in an agreement between you and the Seller, Sony Semiconductor Solutions Corporation or its distributors (hereinafter collectively referred to as the "Seller") will, at the Seller's expense, replace such CMOS image sensors, in the event the CMOS image sensors delivered by the Seller are found to be to the Seller's satisfaction, to have over the allowable range of White Pixels as set forth above under the heading "Spot Pixels Specifications", within the period of three months after the delivery date of such CMOS image sensors from the Seller to you; provided that the Seller disclaims and will not assume any liability after you have incorporated such CMOS image sensors into other products.

Please be aware that Seller disclaims and will not assume any liability for (1) CMOS image sensors fabricated, altered or modified after delivery to you, (2) CMOS image sensors incorporated into other products, (3) CMOS image sensors shipped to a third party in any form whatsoever, or (4) CMOS image sensors delivered to you over three months ago. Except the above mentioned replacement by Seller, neither Sony Semiconductor Solutions Corporation nor its distributors will assume any liability for White Pixels. Please resolve any problem or trouble arising from or in connection with White Pixels at your costs and expenses.

[For Your Reference] The Annual Number of White Pixels Occurrence

The chart below shows the predictable data on the annual number of White Pixels occurrence in a single-story building in Tokyo at an altitude of 0 meters. It is recommended that you should consider taking measures against the annual White Pixels, such as adoption of automatic compensation systems appropriate for each annual number of White Pixels occurrence.

The data in the chart is based on records of past field tests, and signifies estimated number of White Pixels calculated according to structures and electrical properties of each device. Moreover, the data in the chart is for your reference purpose only, and is not to be used as part of any CMOS image sensor specifications.

Example of Annual Number of Occurrence

White Pixel Level (in case of integration time = 1/30 s) (Tj = 60 °C / LCG mode)	Annual number of occurrence
5.6 mV or higher	18 pcs
10.0 mV or higher	10 pcs
24.0 mV or higher	4 pcs
50.0 mV or higher	2 pcs
72.0 mV or higher	1 pcs

- Note 1) The above data indicates the number of White Pixels occurrence when a CMOS image sensor is left for a year.
- Note 2) The annual number of White Pixels occurrence fluctuates depending on the CMOS image sensor storage environment (such as altitude, geomagnetic latitude and building structure), time (solar activity effects) and so on. Moreover, there may be statistic errors. Please take notice and understand that this is an example of test data with experiments that have being conducted over a specific time period and in a specific environment.
- Note 3) This data does not guarantee the upper limits of the number of White Pixels occurrence.

For Your Reference:

The annual number of White Pixels occurrence at an altitude of 3,000 meters is from 5 to 10 times more than that at an altitude of 0 meters because of the density of the cosmic rays. In addition, in high latitude geographical areas such as London and New York, the density of cosmic rays increases due to a difference in the geomagnetic density, so the annual number of White Pixels occurrence in such areas approximately doubles when compared with that in Tokyo.

Material_No.03-0.0.9

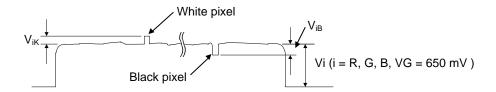
Measurement Method for Spot Pixels

After setting to standard imaging condition II, and the device driver should be set to meet bias and clock voltage conditions. Configure the drive circuit according to the example and measure.

1. Black or white pixels at high light

After adjusting the luminous intensity so that the average value VG of the Gb / Gr signal outputs is 650 mV, measure the local dip point (black pixel at high light, V_{IB}) and peak point (white pixel at high light, V_{IK}) in the Gr / Gb / R / B signal output Vi (i = Gr / Gb / R / B), and substitute the value into the following formula.

Spot pixel level D = ((ViB or ViK) / Average value of Vi) x 100 [%]



Signal output waveform of R / G / B channel

2. White pixels in the dark

Set the device to a dark setting and measure the local peak point of the signal output waveform, using the average value of the dark signal output as a reference.

Spot Pixel Pattern Specification

White Pixel, Black Pixel and Bright Pixel are judged from the pattern whether they are allowed or rejected, and counted.

List of White Pixel, Black Pixel and Bright Pixel Pattern

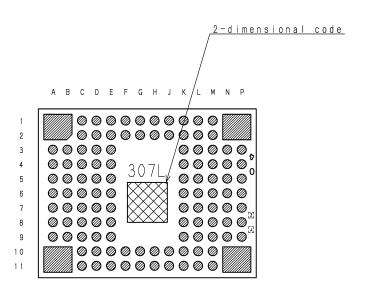
No.	Pattern R G B	It provides by color filter array described in the left.	White pixel Black pixel Bright pixel
1		Same color	Rejected

Note)

- 1." " shows the position of white pixel, black pixel and bright pixel.
 White pixel, black pixel and bright pixel are specified separately according the pattern.
 (Example: If a black pixel and a white pixel is in the pattern No.1 respectively, they are not judged to be rejected.)
- 2. When one or more spot pixels indicated "Rejected" is selected and removed.
- 3. Spot pixels other than described in the table above are all counted including the number of allowable spot pixels by zone.

Marking

Tentative



 $Y: \mbox{ln}$ English upper case character. One character $Z: \mbox{Number, single number}$

DRAWING No. AM-%307LQR(2D)

Notes On Handling

1. Static charge prevention

Image sensors are easily damaged by static discharge. Before handling be sure to take the following protective measures.

- (1) Either handle bare handed or use non-chargeable gloves, clothes or material. Also use conductive shoes.
- (2) Use a wrist strap when handling directly.
- (3) Install grounded conductive mats on the floor and working table to prevent the generation of static electricity.
- (4) Ionized air is recommended for discharge when handling image sensors.
- (5) For the shipment of mounted boards, use boxes treated for the prevention of static charges.

2. Protection from dust and dirt

Image sensors are packed and delivered with care taken to protect the element glass surfaces from harmful dust and dirt. Clean glass surfaces with the following operations as required before use.

- (1) Perform all lens assembly and other work in a clean environment (class 1000 or less).
- (2) Do not touch the glass surface with hand and make any object contact with it. If dust or other is stuck to a glass surface, blow it off with an air blower. (For dust stuck through static electricity, ionized air is recommended.)
- (3) Clean with a cotton swab with ethyl alcohol if grease stained. Be careful not to scratch the glass.
- (4) Keep in a dedicated case to protect from dust and dirt. To prevent dew condensation, preheat or precool when moving to a room with great temperature differences.
- (5) When a protective tape is applied before shipping, remove the tape applied for electrostatic protection just before use. Do not reuse the tape.

3. Installing (attaching)

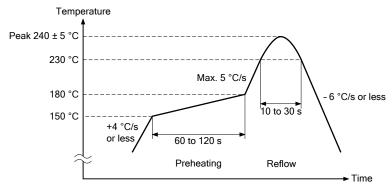
- (1) If a load is applied to the entire surface by a hard component, bending stress may be generated and the package may fracture, etc., depending on the flatness of the bottom of the package. Therefore, for installation, use either an elastic load, such as a spring plate, or an adhesive.
- (2) The adhesive may cause the marking on the rear surface to disappear.
- (3) If metal, etc., clash or rub against the package surface, the package may chip or fragment and generate dust.
- (4) Acrylate anaerobic adhesives are generally used to attach this product. In addition, cyanoacrylate instantaneous adhesives are sometimes used jointly with acrylate anaerobic adhesives to hold the product in place until the adhesive completely hardens. (Reference)
- (5) Note that the sensor may be damaged when using ultraviolet ray and infrared laser for mounting it.

4. Recommended reflow soldering conditions

The following items should be observed for reflow soldering.

(1) Temperature profile for reflow soldering

Control item	Profile (at part side surface)
1. Preheating	150 to 180 °C 60 to 120 s
2. Temperature up (down)	+4 °C/s or less (- 6 °C/s or less)
3. Reflow temperature	Over 230 °C 10 to 30 s Max. 5 °C/s
4. Peak temperature	Max. 240 ± 5 °C



(2) Reflow conditions

- (a) Make sure the temperature of the upper surface of the seal glass resin adhesive portion of the package does not exceed 245 °C.
- (b) Perform the reflow soldering only one time.
- (c) Finish reflow soldering within 72 h after unsealing the degassed packing. Store the products under the condition of temperature of 30 °C or less and humidity of 70 % RH or less after unsealing the package.
- (d) Perform re-baking only one time under the condition at 125 °C for 24 h.

(3) Others

- (a) Carry out evaluation for the solder joint reliability in your company.
- (b) After the reflow, the paste residue of protective tape may remain around the seal glass. (The paste residue of protective tape should be ignored except remarkable one.)
- (c) Note that X-ray inspection may damage characteristics of the sensor.

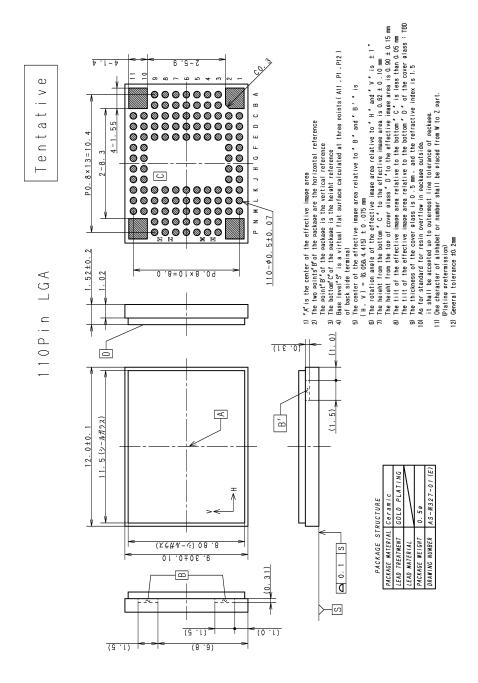
5. Others

- (1) Do not expose to strong light (sun rays) for long periods, as the color filters of color devices will be discolored.
- (2) Exposure to high temperature or humidity will affect the characteristics. Accordingly avoid storage or use in such conditions.
- (3) This product is precision optical parts, so care should be taken not to apply excessive mechanical shocks or force.
- (4) Note that imaging characteristics of the sensor may be affected when approaching strong electromagnetic wave or magnetic field during operation.
- (5) Note that image may be affected by the light leaked to optical black when using an infrared cut filter that has transparency in near infrared ray area during shooting subjects with high luminance.

Material_No.14-0.0.6

Package Outline

(Unit: mm)



List of Trademark Logos and Definition Statements



* Exmor R is a trademark of Sony Corporation. The Exmor R is a Sony's CMOS image sensor with significantly enhanced imaging characteristics including sensitivity and low noise by changing fundamental structure of ExmorTM pixel adopted column parallel A/D converter to back-illuminated type.

STARVIS

* STARVIS is a trademark of Sony Corporation. The STARVIS is back-illuminated pixel technology used in CMOS image sensors for surveillance camera applications. It features a sensitivity of 2000 mV or more per 1 μm² (color product, when imaging with a 706 cd/m² light source, F5.6 in 1 s accumulation equivalent), and realizes high picture quality in the visible-light and near infrared light regions.

Revision History

Date of change	Ver	Page	Contain of Change
2017/7/19	0.1	_	First Edition